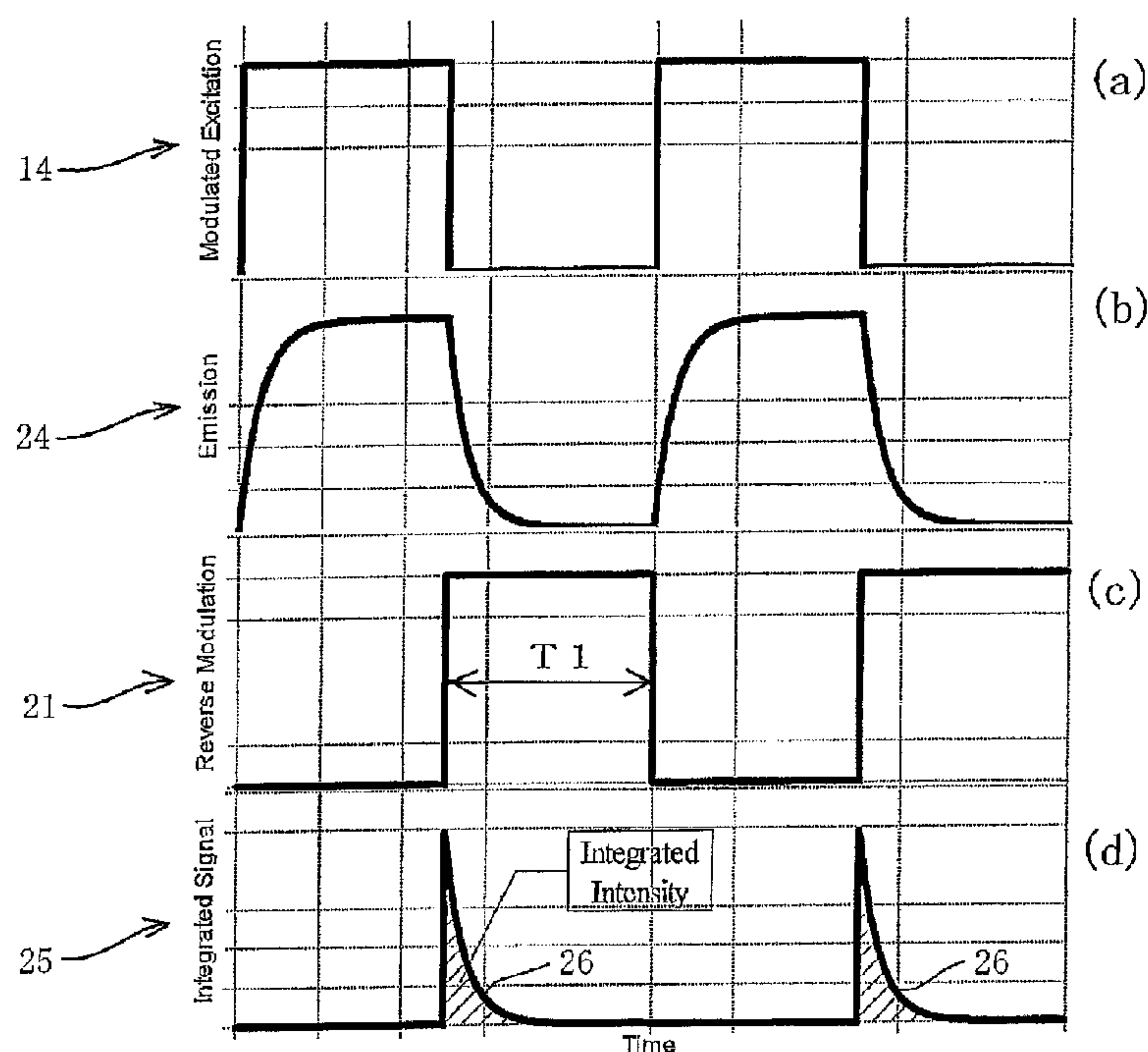




(86) Date de dépôt PCT/PCT Filing Date: 2011/02/15
(87) Date publication PCT/PCT Publication Date: 2012/08/23
(45) Date de délivrance/Issue Date: 2016/04/12
(85) Entrée phase nationale/National Entry: 2013/01/16
(86) N° demande PCT/PCT Application No.: JP 2011/053154
(87) N° publication PCT/PCT Publication No.: 2012/111093

(51) Cl.Int./Int.Cl. *G01N 21/64* (2006.01),
H01L 21/66 (2006.01)
(72) Inventeur/Inventor:
YVES, LACROIX, JP
(73) Propriétaire/Owner:
YSYSTEMS LTD., JP
(74) Agent: OSLER, HOSKIN & HARCOURT LLP

(54) Titre : PROCEDE ET DISPOSITIF POUR MESURER LA DUREE DE VIE D'UNE PORTEUSE
(54) Title: APPARATUS AND METHOD FOR MEASURING A LUMINESCENT DECAY



(57) Abrégé/Abstract:

[Problem] To provide a method and device for measuring carrier lifetime with which the lifetime of a carrier in a sample such as a semiconductor can be measured. [Solution] Continuous light emitted by an emission laser is modulated by a modulator on the excitation side, and excitation light (14), the intensity of which changes to a rectangular pulse, is generated and fed to a semiconductor material. A carrier in a semiconductor is excited, and luminescence (24) generated by recombination is modulated by a modulator on the light-receiving side, and an attenuated ray (26) generated after an excitation period is separated from the light generated in the excitation period. This attenuated ray (26) includes information on the lifetime of the carrier in a sample. Since the attenuated ray (26) is fine light obtained in a very short time, multiple attenuated light rays (26) accumulate and are detected within the exposure time of a CCD element. The carrier lifetime can be identified by the intensity of this detected light.



Abstract

[Problem] An apparatus and method for measuring luminescence decay due to the lifetime of energy carriers inside a material such as a semiconductor is presented.

[Solution] The intensity of a laser is modulated by a light modulating device resulting in a square wave excitation 14, and applied to a semiconducting material. The energy carriers inside the semiconductor are excited, and recombine after a certain time to give rise in part to some light emission 24, which decays in intensity from the time at which the excitation periods end. The decaying light is separated from the light emitted during excitation by another light modulator resulting in 26. This light intensity 26 contains the information related to the carrier lifetime. Because the amount of this light 26 is small and has a very short emission time, a CCD detector is used to be integrated several cycles of the decay periods in order to obtain a reasonable signal. This integrated intensity signal can be used to determine the carrier lifetime.

Specifications

Title of Invention

Apparatus and Method for Measuring a Luminescent Decay

Technical Field

[0001] This invention relates to a measurement method and to an apparatus for measuring the carrier lifetime of a material, by first exciting the carriers inside the material, then measuring the emitted light (luminescence).

Background Art

[0002] The analysis of light emission or luminescence from a material is a wide-spread method for determining material properties such as impurity levels, crystal defects, in the field of semiconductors and other materials.

[0003] Some methods for generating luminescence include electroluminescence or photoluminescence. The free carriers (electrons and holes) are generated by applying electricity to the material, or generated by applying an excitation light source such as that of a laser, both resulting in light emission via the recombination of the electron-hole pairs.

[0004] The electron-hole pairs recombine spontaneously by some probabilistic time after their generation (either electrical or by light excitation). The typical time required for the process to decay is called decay time, or carrier lifetime. The carrier lifetime, as well as other characteristics of the emitted light (for example wavelength, intensity) can be used to determine the condition of the material by means of their dependence on impurities and defects inside the crystal.

[0005] In recent years, there has been a large increase in the demand for high efficiency solar-electric cells based on silicon, requiring better quality control and lower fabrication costs, as well as an increase in demand for larger area cells, hence the importance for high throughput fabrication methods of high quality large area silicon crystals.

[0006] The reduction of cracks and defects in the material used to make solar cells is crucial. Such cracks and defects absorb the electrical energy that the cell has

converted from optical energy. In other words, the whole purpose of the solar cell, to generate electrical energy from light is wasted if the carriers of this energy encounter cracks which then converts this energy into heat. As explained until now, methods such as photoluminescence or electroluminescence are deeply related to the operation mechanism of solar cells. The characteristics obtained from these measurements, particularly the carrier lifetime, are also very sensitive to cracks, the types and level of impurity contents.

[0007] The conventional methods for analyzing solar cell efficiency are based on electrical biasing measurement methods, solar light simulation and others requiring physical contact with the device. Also these methods require the fabrication process to reach near completion before they can be performed. It is difficult to implement such processes in mass production environments without slowing down the fabrication or causing scratches and affecting the cleanliness due to contact application.

[0008] Another example of existing methods is described in Patent Literature 2, where time-correlated single photon counting methods or a streak camera method is used to obtain the carrier lifetime of a material. In the single photon counting method, the emission decay trace is measured directly however the time required to obtain the histogram is too long to be practically applied to the full wafer area. Whereas the streak camera method is forbiddingly costly.

Patent Literature

[0009] Patent Literature 1: European Patent Application Publication WO2007/128060A1
 Patent Literature 2: Japanese Unexamined Patent Application Publication No. 2008-170257

Disclosure of the Invention

Technical Problems Solved by the Invention

[0010] As mentioned so far, there is currently no method of measuring the carrier lifetime directly or obtaining information on cracks and impurity contents that is both fast enough to map a large area of the material, and at the same time not too costly to be used in material production environments.

[0011] The purpose of the present invention is to offer a new method and an apparatus using this method for obtaining information on the energy carriers, by monitoring the light emitted from a material without physical contact and at high speed, in order to implement a low cost carrier lifetime measurement system.

[0012] Furthermore, the present invention targets applications where the need for measuring the spatial variation of the carrier lifetime typically in semiconductors is imminent.

Means for Solving the Problems

[0013] The carrier lifetime measurement method in the present invention consists of obtaining an integrated intensity via accumulated light emitted from a material. This emission is induced by periodically repeated carrier excitations. Decaying emissions follow immediately, are optically separated from the emission occurring during the excitation, and integrated during a time which spans several periods of the excitation cycles.

[0013a] In accordance with one embodiment of the present invention, there is provided a carrier lifetime measurement method comprising material excitation, and detection of light emitted from that material, said method comprising the steps of: exciting the material such that excitation periods are repeated at periodic intervals; optically separating decaying light emitted after an end of the excitation period from light emitted from the material during the excitation period; and supplying a plurality of the separated decaying light emissions to a light detecting device to let the light detecting device accumulate and detect a plurality of the separated decaying light emissions within an integration time which spans a plurality of the excitation periods so as to obtain a lifetime based on an intensity of light accumulated and detected within the integration time.

- [0014] In order to separate the aforementioned decaying emissions that follow the excitation, from the emission occurring during the carrier excitations, the light accumulation may start precisely at the end or after the end of each excitation period, or even partway through the excitation period.
- [0015] Included in the present invention, is a means for periodically modulating or intermittently blocking the excitation source before it is applied to the material.
- [0016] Included in the present invention, is also a means for periodically modulating or intermittently blocking the light emitted from the material before it reaches the light accumulation device.
- [0017] In the present invention, the light accumulation device can be an array of several detector cells, each of which accumulating light spanning several periods of the decaying emission cycles. For example, the detector cells may be arranged in a two dimensional array in order to measure simultaneously the carrier lifetime of an area of the material. Also another method included in this invention can be described a line of detectors moving across the material in order to also obtain the information related to the carrier lifetime of an area on the material.
- [0018] The present invention includes a method where multiple measurements of the lifetime are measured as described above, with increasing modulation frequencies until a non-linear change in the integrated intensity is detected. Using this frequency dependence, it is possible to quantify the lifetime information. Furthermore, taking the ratio of the intensities at different frequencies, it is possible to normalize the intensity dependence of the emission and isolate the carrier lifetime dependence, making it possible to compare areas of different emission intensities.

- [0019] The present invention includes the method of comparing intensities measured at a given modulation frequency to that of the intensity measured without modulation also in order to remove the intensity component of the emission and make possible the isolation of the carrier lifetime component.
- [0020] The above method for isolating the carrier lifetime component of the intensity is also possible by taking the ratio of intensities measured at different modulation waveforms
- [0021] Again, the method for isolating the carrier lifetime component of the intensity is also possible by taking the ratio of intensities measured at modulations which are relatively offset in phase.
- [0022] Moreover, the carrier lifetime component isolation of the intensity is possible by comparing intensities for measurements using intermittent excitation of different duty ratios, where opposite duties are applied to the excitation side compared to the detection side.
- [0023] The present invention includes the methods where the excitation applied to the material is either optical or electrical.
- [0024] The carrier lifetime measurement apparatus of the present invention consists of an excitation apparatus for exciting energy carriers in the material and a detecting apparatus which accumulates the resulting light emission from that material. The present invention also implies an inspection system which may contain such an apparatus. It uses the accumulated optical signal, for which the excitations are periodically applied and immediately followed by decaying emission. These emissions are optically filtered before reaching the light accumulation device while the intensity integration spans several periods of the decaying emission cycle.

- [0024a] In accordance with one embodiment of the present invention, there is provided a carrier lifetime measurement apparatus for exciting a material and detecting light emitted from that material, comprising: an excitation apparatus configured to excite the material such that excitation periods are repeated at periodic intervals; a detection modulation device configured to separate decaying light emitted after an end of the excitation period from light emitted from the material during the excitation period; a light detecting device configured to receive, accumulate and detect a plurality of the separated decaying light emissions within an integration time which spans a plurality of the excitation periods; and a central control and processing unit configured to obtain a lifetime based on an intensity of the light accumulated and detected within the integration time.
- [0025] The apparatus of the present invention includes an excitation source and a modulation apparatus to generate the above mentioned periodicity in the excitation.
- [0026] This excitation source can be of either optical or electrical nature.

- [0027] The apparatus of the present invention includes an apparatus for separating the light emitted by the material when it is emitted during the excitation, from the light emitted by the material during the decaying emission period. This apparatus can be a light modulating apparatus, or an apparatus that periodically blocks the light, while a plurality of decaying emission light cycles can be spanned during the integration by the light accumulation device.
- [0028] In the apparatus mentioned above which includes an apparatus for separating the light emission from the material between the light emitted during the excitation and the light decaying after excitation, the present invention includes the cases when the light accumulation starts precisely at the end, or after the end of the repeated excitation period, or even partway through the excitation period.
- [0029] The apparatus of the present invention can be made using a multitude of detector cells arranged in an array, each of which accumulates light spanning several periods of the decaying emission cycles. In this case, the detector cells may be arranged in a two dimensional array in order to measure simultaneously the carrier lifetime of an area of the material, obtaining a correspondence between a position on the material and a detector cell along with the respective information related to the carrier lifetime. Another configuration for the above included can be a line of detector cells positioned normal moving across the material in order to also obtain the information related to the carrier lifetime of an area on the material.
- [0030] The apparatus of the present invention may also have a wavelength filter or light polarizing filter between the material and the light detection device.
- [0031] The apparatus of the present invention for which includes a periodic excitation apparatus, can be constructed such that a control section makes use of the integrated intensity measured as described above for different excitation cycle frequencies, to compare them in order to remove the intensity component of the signal, and to isolate and quantify the carrier lifetime component.
- [0032] Also the apparatus of the present invention for which includes a periodic excitation apparatus, can be constructed such that a control section makes use of the integrated intensity measured as described above for different excitation cycle frequencies, then compare them with the intensity measured continuously in order to remove the intensity component of the signal, and to isolate and quantify the carrier lifetime component.

- [0033] Also the apparatus of the present invention for which includes a periodic excitation apparatus, can be constructed such that a control section makes use of the integrated intensity measured as described above applying different periodic modulation waveforms, to compare them in order to remove the intensity component of the signal, and to isolate and quantify the carrier lifetime component.
- [0034] Also the apparatus of the present invention for which includes a periodic excitation apparatus, can be constructed such that a control section makes use of the integrated intensity measured as described above applying different relative phase shifts of the modulation, then compare them with the intensity measured continuously in order to remove the intensity component of the signal, and to isolate and quantify the carrier lifetime component.
- [0035] Also the apparatus of the present invention for which includes a periodic excitation apparatus, can be constructed such that a control section makes use of the integrated intensity measured as described above applying different excitation duty ratios of opposite phase between the excitation and the detection, then compare them with the intensity measured continuously in order to remove the intensity component of the signal, and to isolate and quantify the carrier lifetime component.

Effect of the Invention

- [0036] The present invention enables the measurement of information related to the carrier lifetime inside of a material, without physical contact, by monitoring the light emitted from that material.
- [0037] Moreover, this invention makes it possible to measure the uniformity of the carrier lifetime over an area of the material.

Brief Description of the Drawings

- [0038] [Fig. 1] Graph describing the intensity of the light emitted from the material during excitation,
 [Fig. 2] Graph showing the decay curves of the emission due to the carrier lifetime in the material,
 [Fig. 3] Diagram showing a change in the intensity of the light emitted from the material when given a square wave excitation,
 [Fig. 4] Block diagram of the measuring apparatus and measuring method for detecting light emission from the material modulated with opposite phase with

respect to the excitation modulation.

[Fig. 5] Diagram showing the modulated excitation when using a measuring apparatus shown in Figure 4, the waveform emitted from the material, the detector side modulation and the resulting separation of the decaying emission.

[Fig. 6] Graph showing the relationship between the intensity of the accumulated light detector output with change in the modulation frequency of the excitation given to the material of different carrier lifetimes.

[Fig. 7] Graph showing the relationship between frequencies at which the integrated decay light intensity is 50% of its maximum value, as a function of the carrier lifetime.

[Fig. 8] Graph showing the relationship between the integrated intensity at a given frequency, which has been normalized with the intensity obtained at ten times that frequency, and carrier lifetime, in the case of square modulation.

[Fig. 9] Graph showing material data used for simulation in the following graphs. The data represents a change in carrier lifetime values and emission efficiency values as a function of position (x axis) on the material.

[Fig. 10] Diagram showing the modulated excitation, the waveform emitted from the material, the detector side modulation and the resulting separation of the decaying emission, for a change in modulation frequency.

[Fig. 11] Graph showing the integrated intensity as a function of position on the material simulated using the data of Fig. 9, when the two frequencies shown in Fig. 10 and in the case of no modulation, and the ratio of the intensity taken at the two frequencies.

[Fig. 12] Diagram showing the non-modulated excitation, the emitted signal from the material, the detector side non-modulated trace and the resulting integrated signal.

[Fig. 13] Diagram showing the modulated excitation, the waveform emitted from the material, the detector side modulation and the resulting separation of the decaying emission, for the case of a trapezoidal waveform modulation.

[Fig. 14] Graph showing the integrated intensity as a function of position on the material simulated using the data of Fig. 9 for trapezoidal modulation for two frequencies and in the case of no modulation, and the ratio of the intensity taken at the two frequencies.

[Fig. 15] Graph showing the relationship between the integrated intensity at a given frequency, which has been normalized with the intensity obtained at ten

times that frequency, and carrier lifetime, in the case of trapezoidal modulation.

[Fig. 16] Diagram showing the modulated excitation, the waveform emitted from the material, the detector side modulation and the resulting separation of the decaying emission, for the case of a sinusoidal waveform modulation.

[Fig. 17] Graph showing the integrated intensity as a function of position on the material simulated using the data of Fig. 9 for sinusoidal modulation for the two frequencies and in the case of no modulation, and the ratio of the intensity taken at the two frequencies.

[Fig. 18] Graph showing the relationship between the integrated intensity at a given frequency, which has been normalized with the intensity obtained at ten times that frequency, and carrier lifetime, in the case of sinusoidal modulation.

[Fig. 19] Diagram showing the modulated excitation, the waveform emitted from the material, the detector side modulation and the resulting separation of the decaying emission, for a square waveform compared to a sinusoidal waveform at the same frequency.

[Fig. 20] Graph showing the integrated intensity as a function of position on the material simulated using the data of Fig. 9 for square modulation, sinusoidal modulation and in the case of no modulation for reference, and the ratio of the intensity taken at the two different waveforms.

[Fig. 21] Graph showing the relationship between the integrated intensity at a given frequency using a square modulation, which has been divided by the intensity obtained using a sinusoidal waveform, and carrier lifetime.

[Fig. 22] Diagram showing the modulated excitation, the waveform emitted from the material, the detector side modulation and the resulting separation of the decaying emission, for two waveforms where the detector side modulation is relatively phase shifted.

[Fig. 23] Graph showing the integrated intensity as a function of position on the material simulated using the data of Fig. 9 for two different phase shifted modulations, the case of no modulation for reference, and the ratio of the intensity taken at the two different waveforms.

[Fig. 24] Graph showing the relationship between the integrated intensity at a given frequency using a square modulation, which has been divided by the intensity obtained using a relatively phase-shifted waveform, and carrier lifetime.

[Fig. 25] Diagram showing the modulated excitation, the waveform emitted from the material, the detector side modulation and the resulting separation of the

decaying emission, for two square waveforms where at two different duty-ratios, while keeping the reverse phase modulation between excitation and detection.

[Fig. 26] Graph showing the integrated intensity as a function of position on the material simulated using the data of Fig. 9 for square waveforms at different duty-ratios, the case of no modulation for reference, and the ratio of the intensity taken at the two different waveforms.

[Fig. 27] Graph showing the relationship between the integrated intensity at a given frequency using a square modulation with duty 50:50, which has been divided by the intensity obtained using a square modulation with duty 90:10, and carrier lifetime.

[Fig. 28] Diagram showing the modulated excitation, the waveform emitted from the material, the detector side modulation and the resulting separation of the decaying emission, for two different waveforms and two different frequencies.

[Fig. 29] Diagram showing the modulated excitation, the waveform emitted from the material, the detector side modulation and the resulting separation of the decaying emission, for the case of a square wave with duty ratio other than 50:50.

[Fig. 30] A block diagram showing a first embodiment of the measurement method and measuring apparatus in an ideal configuration.

[Figure 31] A block diagram showing a second embodiment of the measurement method and measuring apparatus in an ideal configuration.

Detailed Description of the Preferred Embodiments

[0039] In order to evaluate a material such as a semiconductor, the current invention measures the light emitted (luminescence) from that material.

[0040] The energy of a non-valence electron in the crystal of a material is determined by the position of the conduction band, but can also be determined by a variety of states such as non-radiative centers, impurity levels, or other defect states. If an electron is in a non-thermal-equilibrium excited state, it will eventually recombine with a hole within a probable time giving rise to a carrier lifetime. That recombination causes an energy conversion which can be in the form of light emission, or in the form of vibrations or heat in the material. If the carrier recombines due to defects, impurities or cracks in the crystal, then the probability of emitting light due to natural recombination will be reduced. Because of this, in general the carrier lifetime is shorter in the presence of a high density of crystal

defects. Therefore a measurement of the carrier lifetime is an important means of evaluating the material's defect levels and its crystal quality.

- [0041] It is important for crystalline solar cells to have low defect densities. If electrons (energy carriers) excited by the absorption of solar light get trapped by defect states, their energy gets reconverted to light or transformed into heat such that this electrical energy can no longer be extracted. Again In solar cells the carriers generated by light absorption are converted to electricity once they reach the electrodes, however if these electrodes are not within the distance that the carriers can travel in their lifetime, the electricity cannot be generated. Therefore longer carrier lifetimes allow for larger the distance between electrodes and hence leaving more area for light absorption.
- [0042] The ability to measure the carrier lifetime distribution across the entire solar cell surface without contact and at high speed would enable the monitoring of the solar cell manufacturing process, especially between individual processing steps. For example, even before the solar cell fabrication process is completed, within the steps required to form the necessary high quality p-n junction, crystal growth, ion implantation, conducting layer annealing or other non-reversible processes, measurement of the carrier lifetime across the entire surface would allow an evaluation immediately after that very step. Based on the result expressed as an image of the carrier lifetime uniformity, not only could the process be halted and defective material not be allowed to continue into production, but also this information could be used to pin-point the problematic areas and help improve the production yield.
- [0043] The present invention seeks to provide a low cost and high speed method and apparatus for measuring the carrier lifetime of a material via contact-less monitoring of the material luminescence. It is characterized by its ability to distinguish or separate the light emitted during carrier excitation from the light emitted after this excitation. It is further characterized by the ability to record a signal based on the repeated accumulation of the separated light.
- [0044] In the embodiments below, photoluminescence is used to evaluate the carrier lifetime. In photoluminescence, light is used to excite the electrons which recombine with holes to emit light. However the present invention is not limited to photoluminescence and the present invention can also be carried out using electroluminescence where the excitation process is electrical.

- [0045] Figure 1 shows a graph representing the continuous excitation and luminescent emission for a wafer such as silicon at a given position, where the horizontal axis is time and the vertical axis is emission intensity. Ideally the continuous intensity of the luminescence has an amplitude given by $A_{cw}P$, where A_{cw} is the amplitude of the excitation, and P is the probability that the excited energy gets reconverted to light. The hatched area represents the integrated intensity $A_{cw}PT_m$ of the luminescence during a time T_m during which the measurement takes place. Although the carrier lifetime plays a role in the process described here, that specific information cannot be extracted from the integrated intensity value.
- [0046] Figure 2 shows a graph representing the decaying light emission from a material such as silicon after light excitation, and the corresponding carrier lifetime position, with time as the horizontal axis and normalized emission intensity as the vertical axis.
- [0047] With some probability P , once a photon is absorbed it can be re-emitted as a photon of lower energy, after a time τ determined by the material characteristics. When an infinite number of photons follow this process, the probabilistic distribution is described by an exponential decay curve. Ideally, for an excitation described by the delta function $A\delta$, the probability distribution for the light re-emission is $APe^{-t/\tau}$ (where e is the natural number) as shown in Figure 2. This time τ is to be defined as the carrier lifetime. In other words, the carrier lifetime τ can be described as the time required for the $1/e$ fraction of the luminescence to decay with respect to its initial intensity.
- [0048] However, when attempting to measure this time τ , extremely high speeds and at the same time extremely high sensitivity and timing precision is required of the instrument in order to accumulate the average characteristic of many photons. Also in order to average enough photons for carrier lifetimes in the microsecond range, a relatively long measurement time is required. Moreover since the measurement of very weak light emission is necessary, the background signal level due to usual instrument noise makes the task substantially difficult.
- [0049] The graph of Figure 3 shows the relationship between time and the emission intensity from the material when given a sharp pulse of excitation.
- [0050] The thick continuous line of Figure 3 describes the light emission. The curve shows an increase of intensity during the sharp pulse, followed by a decrease in emission after the end of the excitation. The time integrated intensity of this

emission, described as the hatched region in Figure 3, resulting from an excitation pulse of amplitude A_p during a time T_p , is simply $P T_p A_p$. This accumulated intensity of the emission has dependence on the emission probability P , however the carrier lifetime component still cannot be separated or extracted from it.

[0051] However, the emission shown in Figure 3 shows the characteristic described in Figure 2 of the exponential decay $A P e^{-t/\tau}$ on the falling edge in which carrier lifetime parameter τ is convoluted.

[0052] In the present invention, the decaying emission portion of Figure 3, following the increase and decrease of the excitation, is isolated in order to measure the carrier lifetime. However in order to extract and measure only that portion of the emission, since the pulse duration can be very short, a very fast device for detecting the light is necessary. Also since the decaying emission intensity can be very weak, it is necessary to have an apparatus that continuously and repeatedly acquires the emission signal in order to obtain a reasonable signal.

[0053] The basic embodiment of the present invention's apparatus and measurement method is described in the block diagram of Figure 4, where an excitation is applied to a material, and the resulting multiply repeated and extracted decaying light emissions from that material are measured.

[0054] The apparatus 1 of Figure 4 contains an excitation apparatus 10 and a detecting apparatus 20. The excitation apparatus 10 includes an excitation source 11 and a modulation device 12. The detecting apparatus 20 is composed of a modulation device 21, a filter 22 and a light accumulation device 23. The excitation source 11 is typically a continuous emission solid state laser while 12 and 21 are acousto-optic modulators. 23 is a device that integrates light by accumulating it over time and at specific positions, such as for example a CCD (charge coupled device) array. 22 is a wavelength filter or an optical polarization filter.

[0055] The light 14 has a waveform described by excitation emitted by 11 and modulated by 12 and is shown in Figure 5 (a). The continuous light 13 of Figure 4 enters the acousto-optic modulator 12 which rapidly switches its refractive index to allow light to pass. The intensity of the resulting light intensity at 14 therefore rises and drops in a square wave manner as described in Figure 5 (a). The modulated light 14 shown in Figure 5 (a) has a duty ratio of 50%.

[0056] The luminescence 24 emitted from a semiconducting material 30 such as silicon

excited by the modulated excitation 14 has intensity variations shown in Figure 5 (b). Just like described in Figure 3, the luminescence 24 sharply rises in intensity upon the start of the sharp excitation rise of 14, then shows decaying intensity when the excitation drops.

- [0057] The modulation waveform applied by the modulation device 21 on the detection side of the apparatus is shown in Figure 5 (c). The modulator 21 is designed to be reversely synchronized with the modulated excitation 14 waveform shown in Figure 5 (a), in such a way that when the excitation intensity drops in 14, the light begins to be allowed through in the acousto-optic modulation 21. Both modulators 12 and 21 and thus synchronized using a control signal and set to operate in such a mutually reversed modulation.
- [0058] The separated light 25, originating from the light 24 emitted from the semiconductor material 30 due to the modulated excitation 14, and allowed to pass by the modulator 21 is shown in Figure 5 (d). The light allowed to pass through begins at the end of the excitation 14 therefore only contains the decaying intensity portion of the emission as shown in the hatched area 26.
- [0059] As described in Figure 5 (d), applying a mutually reversed synchronized modulation such as in Figure 5 (c) is ideal for extracting only the decaying portion of the emission 26 from the luminescence 24.
- [0060] In addition, Figure 5 (b) represents the emission 24 of a single point from a certain area on the semiconductor material 30 from which the decaying light 26 is separated. The area of that single point is then reflected as a single pixel or cell of the CCD detector array in the detection apparatus 23.
- [0061] The intensity of light 25 shown in Figure 5 (d) then passes through filter 22 before reaching the detecting device 23, so that only some components of the decaying light 26 are extracted. The CCD detector cells of the detecting device 23 accumulate light during a certain integration time and the integrated intensity is then stored in memory. With respect to this integration time, the modulations of Figures 5 (a), (c) are much faster such that several cycles of the decaying light 25 shown in Figure 5 (d) can be accumulated in a single measurement.
- [0062] As described in Figures 2 and 3, the carrier lifetime τ characterizes the light 26, the decaying part of the emission immediately following the end of the excitation, and this light is accumulated multiple times by the measurement apparatus in order to

effectively extract the carrier lifetime information.

- [0063] Although the light 26 generated by the excitation light 14 is weak, The process of rapidly applying the modulations shown in Figures 5 (a) and (c) makes it such that several occurrences of the decaying light 26 are accumulated during the integration time. In result, the signal due to the light accumulated by the detecting device 23 from the light 26 can be high enough compared to the detector's and other sources of noise, and a significant signal can be extracted.
- [0064] The decay light 26 accumulated by the detecting device 23 as an integrated intensity, and normalized with respect to their high frequency saturation value, is shown in the graph of Figure 6, plotted as a function of the frequency of the excitation and detection modulation devices 12 and 21. The vertical axis shows the intensity, and the horizontal axis the modulation frequency. The resulting simulation of the intensity, for a fixed integration time, is shown in Figure 6 where the curves for discrete steps of material carrier lifetime of 50nsec, 70nsec, 100nsec, 150nsec, 200nsec, 300nsec and 500nsec are plotted.
- [0065] The graph of Figure 6 shows that at low modulation frequency, when the modulation period is much longer than the carrier lifetime parameter τ , nearly no light or relatively very little of the emission decay light 26 is accumulated during the integration time. And as the frequency is increased, proportionally more and more of decayed light 26 is accumulated so that the intensity increases linearly.
- [0066] Furthermore, as the frequency increases and the period of the modulation T_1 shown in Figure 5 (c) of the luminescence 24 approaches the carrier lifetime parameter τ , a super-linear increase in the intensity is observed. A further increase of the modulation frequency eventually causes the accumulation of the decaying light 26 to saturate, and as such the intensity measured eventually saturates as shown in Figure 6.
- [0067] When the excitation modulation device 12 operates at a duty ratio of 50% and the detection modulation device 21 operates at a duty ratio of 50%, the theoretical saturation level of the intensity is $\frac{1}{4}$ of the luminescence intensity A_{cwP} shown in Figure 1 for the case of continuous excitation.
- [0068] Figure 6 shows a solid line at 50% of the saturation intensity for a series of different carrier life times. Near the crossing of the integrated intensity of each curve and the 50% line, a region of near-linear trend is seen as function of the

logarithmic frequency scale is seen.

- [0069] A frequency in this range is desirable when selecting a single frequency for the excitation modulation frequency and the detection modulation frequency of the modulations shown in Figures 5 (a) and (c) respectively. In this case Figure 6 shows that the normalized integrated intensity will increase for a longer carrier lifetime, or decrease for a shorter carrier lifetime.
- [0070] Again, assuming the same emission efficiency giving rise to the same emission intensity A_{cwP} for several points on a material, and using the same excitation modulation frequency (detection modulation frequency), then each of the measurement intensity should represent the carrier lifetime for that corresponding region of the material. For long carrier lifetime the measured intensity should be high, and for short carrier lifetime the measured intensity should be low, such that the value of the carrier lifetime is directly represented by the intensity of the measured signal.
- [0071] Then based on the simulation of Figure 6, the relationship between the crossing frequency of each plotted line for each nominal carrier lifetime, where the intensity reaches 50% of its saturated value, and the carrier lifetimes, is plotted in the graph of Figure 7. The horizontal axis shows carrier lifetime, and the vertical axis $1/\text{frequency}$ or in other words the modulation periods described in Figures 5 (a) and (c) and for which the intensity reached 50% for the nominal carrier lifetime in that material.
- [0072] The result obtained from the simulation shown in Figure 7 is a linear relationship between the carrier lifetime and the modulation at which the measured intensity is 50% of its saturation value and this relationship can be expressed by a parameter $K=0.13$. In other words if the modulation frequency at which the integrated intensity is 50% of its saturation value is known as F , then the carrier lifetime τ_x is given by $\tau_x=0.13/F$. In addition, the relationship described in Figure 7 is not limited to the carrier lifetime range 50nsec to 500nsec.
- [0073] Also the above relationship is not limited to the crossing when the integrated intensity reaches 50% of its saturation value. A similar linear relationship can be obtained for relative intensity crossings of, for example, 40% or 60%.
- [0074] The variations in the above light intensity are dictated by both the material's ability to emit light, or the probability of light emission giving rise to the intensity A_{cwP} ,

and the carrier lifetime component of the emission. However as explained using Figures 5 and 6, by sweeping the modulation frequency it is possible to precisely quantify the carrier lifetime component.

[0075] Moreover, once the carrier lifetime has been quantified for 1 point on a material, it is possible to extract and quantify other points by simply using measurements at 2 fixed modulation frequencies, and taking the ratio between the two intensities in order to remove the intensity (light emission probability) component. Using this method it is not necessary to sweep the modulation frequency in order to isolate and quantify the carrier lifetime, hence a high speed measurement of the carrier lifetime becomes possible. This measurement method is explained in the following.

[0076] Figures 9 through 11 show the simulated results of a method for extracting the carrier lifetime information, using assumed material properties of the emission probability and carrier lifetime as a function of position.

[0077] Figure 9 shows the hypothetical simulation data for a material that has relatively different properties and trends for the emission probability and the carrier lifetime as function of position. The horizontal X axis represents position on the material. This material is assumed to have emission efficiency slowly decreasing from the left toward the right, while its carrier lifetime characteristics vary in a sort of wave-like trend as shown in the Figure.

[0078] Given a single position on the X axis of Figure 9, the simulated measurement at 1 MHz modulation is shown in Figure 10 (A), where the applied excitation modulation 12 and the detection modulation 21 are reversed in phase. The waveforms of Figure 10 (A) are the same as those shown in Figure 5, (a) the excitation modulation waveform, (b) the waveform of the luminescence emitted from the material, (c) the detection side modulation, and (d) the resultant separated decaying portion of the light intensity.

[0079] By accumulating the separated light described in Figure 10 (A) (d) during a given integration time using a CCD detector, an integrated intensity is obtained. Figure 11 shows a graph of this intensity as a function of position for a modulation frequency of 1 MHz as curve 31 plotted in a double dotted dashed line.

[0080] Just as in Figure 10 (A), Figure 10 (B) shows (a) the excitation modulation waveform, (b) the waveform of the luminescence emitted from the material, (c) the

detection side modulation, and (d) the resultant separated decaying portion of the light intensity, where the applied excitation modulation 12 and the detection modulation 21 are reversed in phase, however for a modulation frequency of 10MHz. In Figure 11, the resulting integrated intensity as a function of position is shown as curve 32 plotted in a continuous line.

- [0081] By taking the ratio of the intensity distribution obtained at 1 MHz curve 31 with respect to the intensity distribution curve 32 obtained at 10 MHz, one obtains curve 33 also shown in Figure 11. This curve closely resembles the original carrier lifetime data of Figure 9, demonstrating how taking the ratio of measurements obtained at 2 different frequencies allows the extraction of the carrier lifetime information.
- [0082] The result of the simulation of Figures 9 to 11 is also shown in Figure 8 where the ratio of the intensities obtained by integrating the light 26 at 1 MHz versus the intensities obtained by integrating the light 26 at 10 MHz for the distribution of material properties is plotted in the vertical axis as a function of the carrier lifetime parameter τ in the horizontal axis. Also shown are nominal carrier lifetimes $\tau_1=130\text{nsec}$, $\tau_1/5$ and 2τ within which the material properties of Figure 9 fluctuate.
- [0083] As shown in Figure 8, the relationship between the obtained measurement intensity and the carrier lifetime is nearly linear. From this it can be concluded that taking the ratio of 2 integrated intensities measured at different modulation frequencies, it is possible to normalize the intensity for different material emission probability A_{cwP} , in order to obtain a signal which represents the change in the carrier lifetime.
- [0084] The case where no modulation is applied to the excitation or to the emitted light is shown in Figure 12. The continuous excitation is shown in (a), the resulting luminescence in (b), the lack of detection modulation in (c) and the resulting unaffected continuously excited luminescence reaching the CCD detector is shown in (d).
- [0085] The corresponding integrated intensity from the accumulation of the light reaching the CCD detector described in Figure 12 is also shown in Figure 11, after dividing this intensity by 4. The curve 34 is therefore $\frac{1}{4}$ of the emitted at continuous excitation plotted as function of position. A close resemblance is seen when comparing curve 32 obtained at 10MHz to curve 34. Therefore it is reasonable to state that taking the ratio of curve 31 measured at 1MHz with $\frac{1}{4}$ of the intensity

obtained during continuous excitation without any applied modulation will result in approximately the same curve 33.

- [0086] Hence normalizing integrated intensity of the modulated luminescence with the continuously excited luminescence enables the extraction of the carrier lifetime information.
- [0087] In the above explanation, using the preferred embodiment describe, the excitation modulation of 12 and the detection modulation of 21 were assumed to have perfectly sharp square wave rise and drop characteristics, and moreover to be operating in perfect synchronization. However an actual modulating device may not have the inability to produce such a square wave, slight deviations from perfect synchronizations and also the effects of noise in the system may affect the final modulation waveform characteristics.
- [0088] However the present invention's method and apparatus can still extract the information related to the carrier lifetime as described above, even though deviations from perfect timing, from ideal excitation modulation waveform or from ideal detection modulation waveforms exist.
- [0089] As an example, the excitation light emitted by 11 is modulated by 12 resulting in a trapezoidal waveform shown in Figure 13 (a). For this case, the light emitted by the material is shown in (b). A similar trapezoidal modulation is applied on the detector side by 21 and shown in (c). The modulation waveforms of (a) and (c) are modulating and synchronized at the same frequency and mutually reverse in phase. The waveform of the resulting light 25 which has been extracted from the luminescence 24 before reaching the detecting device 23, is shown in (d).
- [0090] Because the modulation waveform (c) overlaps waveform (b) modulating the emitted light (a), a portion of the light 26a of light 25 shown in (d) does not contain only light from the decaying intensity, but also contains some portion of the light emitted during excitation.
- [0091] The same material properties used earlier, for carrier lifetime and emission probability shown in Figure 9, are then used for the case described in Figure 13 to simulate the resulting integrated intensity.
- [0092] Figure 14 shows the result of applying the waveforms of Figure 13 (a) and (c) at a frequency of 1 MHz, where the double dotted dashed line 31a represents the integrated intensity of the separated light 25 reaching the CCD detector. Again,

for applying the modulation waveforms of Figures (a) and (c) at a frequency of 10 MHz, the resulting integrated intensity curve 32a is plotted as a continuous line in the Figure.

- [0093] The ratio of the intensity measured for 1MHz modulation and the intensity measure for 10MHz modulation is shown as trace 33a. This curve bears strong resemblance to the carrier lifetime data shown in Figure 9. That is, even using the modulation characteristics of Figure 13 and using the ratio of the intensity obtained at 2 different frequencies, the information pertaining to the carrier lifetime can be extracted.
- [0094] The ratio of the intensities measured for 1MHz and 10 MHz modulation is plotted with respect to nominal carrier lifetime in Figure 15. Figure 15 was evaluated in the same way as Figure 8. Figure 15 shows that this ratio, based on the modulation properties described in Figure 13, has a near linear relationship with the increase of the carrier lifetime, therefore showing the correspondence between the measured ratio and the carrier lifetime.
- [0095] Again, $\frac{1}{4}$ of the light intensity emitted according to the continuous excitation described in Figure 12 (b) is plotted in Figure 14 as curve 34 as a function of position. The curve is essentially identical to the curve 32a for the above 10MHz trapezoidal modulation. Therefore the ratio of the integrated intensity obtained using a trapezoidal modulation versus the integrated intensity measured for continuous excitation may also be used to extract the carrier lifetime information.
- [0096] In the simulation shown in Figure 16, an excitation resembling a sinusoidal waveform is used and shown in (a). For this case, the light emitted by the material 24 is shown in (b). A similar sinusoidal modulation is applied on the detector side and shown in (c). The modulation waveforms of (a) and (c) are modulating and synchronized at the same frequency and mutually reverse in phase. The waveform of the resulting light 25 which has been extracted from the luminescence 24 before reaching the detecting device 23, is shown in (d).
- [0097] Again because the modulation waveform (c) overlaps the waveform (b) modulating the emitted light (a), a portion of the light 26a of light 25 shown in (d) does not contain only light from the decaying intensity, but also contains some portion of the light emitted during excitation.
- [0098] In Figure 17, the curve 31b representing integrated intensity obtained from the

sinusoidal modulation of Figure 16 at 1MHz, the curve 32b of that obtained from at 10MHz for a similar modulation, and curve 33b obtained from the ratio of curves 31b and 32b are shown. This resulting curve 33b closely resembles the carrier lifetime component of the material data of Figure 9, showing that it is possible to extract the information related to the carrier lifetime.

- [0099] Again, if the curve 31b is normalized using curve 34 representing $\frac{1}{4}$ of the intensity obtained in continuous excitation, the resulting characteristics also resemble those of curve 33b.
- [0100] Figure 18 shows a near linear relationship between the carrier lifetime and the ratio of two integrated intensities measured at frequencies 1MHz and 10MHz, as well as the ratio of these frequencies. Figure 18 hence shows that even for a sinusoidal modulation the measurement and ratio of 2 different modulation frequencies has a correspondence to the information relating to the carrier lifetime.
- [0101] In the following, other methods where normalizing the measured intensity using the ratio of 2 modulation, such as in the above using different frequencies or by using $\frac{1}{4}$ of the continuous excitation intensity, in order to remove the emission intensity dependence and extract the carrier lifetime are given.
- [0102] The simulation described by Figure 19 is the case where the ratio of the intensities is taken between two different waveforms.
- [0103] The modulation waveforms of Figure 19 (A) are the same as those of 10 (A). A square wave excitation modulation is shown in (a) and a square wave detection modulation in (c). The waveforms in (a) and (c) are synchronized at 1MHz and mutually opposite in phase. The separated light to be accumulated by the CCD during the integration is shown in (d). The result of applying this to the material properties as a function of position is shown in curve 31c of Figure 20 plotted as a double dotted dashed line.
- [0104] The modulation waveforms of Figure 19 (B) are the same as those of Figure 16, where the excitation modulation (a) and the detection modulation (c) are sinusoidal curves. The modulations of (a) and (c) are applied at the same frequency and are phase shifted by 180 degrees. Further, they are applied at the same 1MHz frequency as the square wave modulations of Figure 19 (A) (a) and (c). The result of this sinusoidal modulation is shown as curve 32c in Figure 20, plotted as a solid line.

- [0105] The ratio of the square wave modulated intensity 31c versus the sinusoidal wave modulated intensity 32c is shown as curve 33c of Figure 20. It shows that this curve closely resembles the curve describing the carrier lifetime material data of Figure 9.
- [0106] The ratio of the square wave modulated intensity versus the sinusoidal wave modulated intensity is plotted in Figure 21 with respect to nominal carrier lifetime. From Figure 21, we see that the trend for increased intensity ratio corresponds to the increasing carrier lifetime.
- [0107] The simulation described by Figure 22 is the case where the ratio of the intensities is taken between two waveforms but for which the relative phase between the excitation modulation waveform and the detection modulation waveforms are offset.
- [0108] The modulation waveforms of Figure 22 (A) are the same as those of 10 (A) or 19 (A). The square waveforms in (a) and (c) are synchronized at 1MHz and mutually phase shifted by 180 degrees. The separated light to be accumulated by the CCD during the integration is shown in (d). The result of applying this to the material properties as a function of position is shown in curve 31d of Figure 23 plotted as a double dotted dashed line.
- [0109] The modulation waveforms of Figure 22 (B) display zero mutual phase shift. Both waveforms shown in (a) and (c) are square waves of duty ratio 50% applied synchronously at 1MHz. The resulting distribution of applying this to the material properties is shown in figure 32d of Figure 23.
- [0110] The ratio of the modulated intensity 31d versus the modulated intensity 32d is shown as curve 33d of Figure 23. It shows that this curve closely resembles the curve describing the carrier lifetime material data of Figure 9.
- [0111] Figure 24 shows the relationship between nominal carrier lifetime and the ratio (integrated intensity resulting from modulations of Figure 22 (A) / integrated intensity resulting from modulations of Figure 22 (B)). From Figure 24 we see that the carrier lifetime information can be extracted using the ratio of integrated intensities measured using different relatively phase-shifted square waves modulations on the detection side (c) with respect to the excitation square waves (a).
- [0112] The simulation described by Figures 25 to 26 demonstrate how the carrier lifetime

information, from the material data of Figure 9, can be extracted using the ratio of measured intensities from modulations having different duty ratios.

- [0113] The modulation waveforms of Figure 25 (A) are the same as those of Figures 10 (A), 19 (A) or 21 (A), where the excitation modulation is shown in (a) and the detection modulation is shown in (c) are mutually inverted square waves synchronized at 1MHz. The modulation waveforms of Figure 25 (B) are also mutually inverted square waves synchronized at 1 MHz with excitation modulation shown in (a) and detection modulation shown in (c). However, compared to Figure 25 (A) which shows modulations with duty ratio of 50:50, those in Figure 25 (B) have a modulation duty ratio of 90:10.
- [0114] In Figure 26, the intensity integrated over the modulation described by 25 (A) is plotted as a double dotted dashed line 31f, and the intensity integrated over the modulation described by 25 (B) is plotted as the continuous line 32f. Again the ratio of curves 31f and 32f is shown as 33f. Again, the curve 33f is seen to closely resemble the curve describing the carrier lifetime material data of Figure 9.
- [0115] Figure 27 shows the relationship between nominal carrier lifetime and the ratio (integrated intensity resulting from modulations of Figure 25 (A) / integrated intensity resulting from modulations of Figure 25 (B)). From Figure 27 we see that the carrier lifetime information can be extracted using the ratio of intensities measured using modulation waveforms of different duty ratios.
- [0116] Each of the above embodiments were described in the following example configurations.
- (1) The case where the ratio of measured intensity is taken for two different modulation frequencies
 - (2) The case where the ratio of intensities is obtained by dividing the intensity measured during modulation by the intensity obtained during continuous excitation.
 - (3) The case where the modulation are not described by square waveforms on either the excitation side or the detection side.
 - (4) The case where the ratio of intensities is obtained from two modulations with waveforms having different relative phase shifts.
 - (5) The case where the ratio of intensities is obtained from two modulations having different phase shifts between the excitation modulations with respect to the detection modulation.
 - (6) The case where the ratio of intensities is obtained from modulations having two

different duty ratios.

- [0117] It is also possible to combine the above conditions. For example, the ratio of the intensity obtained using a square wave modulation at 1 MHz shown in Figure 28 (A) with respect to the intensity obtained using a sinusoidal wavelength modulated at 10 MHz shown in Figure 29 (B), can also be used to extract the information pertaining to the carrier lifetime.
- [0118] Again, in the examples such as shown in Figures 5 and 10 (A), it was shown that the light emitted during material excitation and the decaying intensity occurring after the excitation could be separated using two square waves, at 50% duty and opposite phase, applied as the excitation modulation (a) and the detection modulation (c). Regarding this, as the example describe by Figure 29, the duty ratio and phase shifts are not limited to 50% and 180 degrees. In the example of Figure 29, with duty ratio of 40% and a phase shift of 144 degrees between the excitation and the detection modulation, it is also still possible to separate the component of the decaying emission.
- [0119] The apparatus 40 in the preferred embodiment of Figure 30 describes the ideal configuration for implementing the measurement method described up to this point.
- [0120] Just as for the apparatus 1 of the basic embodiment of Figure 4, the excitation apparatus 10 is made up of an excitation source 11 and an excitation modulation device 12. The excitation source 11 is a solid state laser and the modulation device 12 an acousto-optic modulator. The light 13 emitted by the excitation source, modulated by 12 becomes the modulated excitation light 14.
- [0121] The lens 41 placed after the modulation device 12 serves to guide the excitation light 14 onto a certain region in an area of the material 30. Lens 41 can be a collimator lens, a large focusing lens, a defocusing lens or a combination of these, such that the excitation is optimized at the position of material 30.
- [0122] The detection apparatus 20 is made up of a modulation device 21 and a light detecting device 23. The modulation device 21 is an acousto-optic modulator. A collimator lens 42 is positioned between the material and the modulation device 21. The luminescence 24 emitted from the material 30 from a certain region passes through the collimator lens 42, some of that light passes through modulation device 21, such that the separated light 25 reaches the detecting device 23. The detecting device 23 is an array of detector cells from a CCD, before which a

camera lens 43 is placed to focus the separated light 25. In addition, the detection device 21 can be equipped with filter 22 shown in Figure 4 if necessary.

- [0123] If the array of detector cells of the CCD detector device 23 are arranged in a two dimensional array, the luminescence 24 emitted from the material 30 from several positions in an area are integrated simultaneously by each of the CCD detector cell making it possible to obtain the carrier lifetime information and correlate that information with each position. Furthermore, for each of the CCD detector cell, the measured integrated intensity is processed and compared to obtain a distribution curve such as 33 in Figure 11, in order to extract the information pertaining to the carrier lifetime of individual points within a large area on the material.
- [0124] Again, if the array of detector cells of the CCD detector device 23 are arranged in a single or multiple rows, material 30 can be moved step-wise or continuously in a direction normal to these rows by a translation motion device 45, in such a way that the CCD detector device 23 may sequentially acquire luminescence from a large area of material 30. This can also be accomplished by fixing the position of material 30 while moving the measurement apparatus 40.
- [0125] As shown in Figure 30, the measurement apparatus 40 is equipped with a modulation control unit 46. From this control unit 46, the excitation modulation device 12 and the detector modulation device 21 are controlled, and as shown in each Figure, applies modulations to the excitation light and the emitted light.
- [0126] The measurement apparatus 40 is also equipped with central control and processing unit 47, which controls the excitation source 11 as well as the modulation devices 12 and 21. Also, for each integration time during which the accumulated emission intensity is digitized by the CCD measurement device, saved to memory by the control and processing unit 47, where intensity ratios are taken resulting in curves such as shown in 33 of Figure 11. For each detector cell of the CCD results a pixel with an intensity correlated to the carrier lifetime at a certain position within an area of material 30.
- [0127] The information processed by unit 47 giving the carrier life time for positions on the material within a certain area can then be displayed as carrier lifetime values in a table, or the result can be represented as a shade in an image. In the latter case each of the CCD detector cells are represented by a pixel in that image.

- [0128] In figure 31, the measurement apparatus 40A is equipped with a beam splitter 51 to separate the luminescence 24 emitted from material 30, then the separated light is collimated using a second camera lens 52. This portion of the emitted light does not go through the detector modulation device, and is accumulated by a second measurement device 53. In measurement apparatus 40A, the accumulation of both a modulated intensity of the luminescence 24 and non-modulated intensity of the luminescence 24 can be performed in a single measurement.
- [0129] A second modulation device could also be inserted between the beam splitter 51 and the detector device 53 in order to enable the measurement of two different modulations of the luminescence 24 in a single measurement.
- [0130] In addition, a variety of modifications are possible, and the present invention is not limited to the above embodiments.
- For example if the excitation source 11 were an intermittently pulsed laser, then the modulation device 12 would not be required in order to obtain modulations with a variety of duty ratios. Again, if the detector device were such that it was possible to intermittently impede the signal from be accumulated into memory within that device, then even without the modulation device 21 it would be possible to isolate the decay luminescence, integrate that signal over a fixed integration time to similarly extract the carrier lifetime information.
- [0131] It is also possible to replace the excitation source 10 with a device which is not a light source, but that can excite carriers within material 30 periodically using electrical excitation so that light is emitted during the electron-hole pair recombination via an electroluminescent process, thereby enabling measurement of the carrier lifetime.
- [0132] The although the present invention's apparatus and measurement methods have foreseeable applications on typical materials such as silicon (Si), indium phosphide (InP), silicon carbide (SiC), gallium arsenide (GaAs), silicon germanium (SiGe), germanium (Ge), compound chalcopyrite (CuInS₂), crystalline or polycrystalline chalcopyrite alloys (Cu (In, Ga) Se₂), fullerenes (C₆₀) and other organic semiconductors, it is not limited to such materials.
- [0133] Also as long as some method of exciting carriers inside a material such that they eventually drop down to a lower energy level, were it optical or electrical, the applications can extend to materials such organic compounds and polymers.

Reference Sign's List

- [0134] 1 Measurement apparatus
- 10 Excitation apparatus
 - 11 Excitation source
 - 12 Modulation device
 - 13 Continuous light
 - 14 Excitation light
 - 20 Detector apparatus
 - 21 Modulation device
 - 22 Filter
 - 23 Light accumulation device
 - 24 Luminescence
 - 25 Separated light
 - 26 Decaying light
 - 30 Semiconductor material
 - 40 Measurement apparatus
 - 41 Lens
 - 42 Collimating lens
 - 43 Camera lens
 - 45 Translation device
 - 46 Modulation control unit
 - 47 Main control and processing unit
 - 51 Beam splitter
 - 52 Camera Lens
 - 53 Light accumulation device

The embodiments of the present invention for which an exclusive property or privilege is claimed are defined as follows:

1. A carrier lifetime measurement method comprising material excitation, and detection of light emitted from that material, said method comprising the steps of:
exciting the material such that excitation periods are repeated at periodic intervals;
optically separating decaying light emitted after an end of the excitation period from light emitted from the material during the excitation period; and
supplying a plurality of the separated decaying light emissions to a light detecting device to let the light detecting device accumulate and detect a plurality of the separated decaying light emissions within an integration time which spans a plurality of the excitation periods so as to obtain a lifetime based on an intensity of light accumulated and detected within the integration time.
2. The carrier lifetime measurement method according to claim 1, wherein the decaying light is separated from the light emitted during the excitation period by starting to receive the light emitted from the material at the same time or after the end of the excitation period.
3. The carrier lifetime measurement method according to claim 1, wherein both a portion of the light emitted during the excitation period as well as the decaying light are separated from a remaining portion of the light emitted during the excitation period by starting to receive the light emitted from the material partway through the excitation period.
4. The carrier lifetime measurement method according to any one of claims 1 to 3, wherein the excitation applied by an excitation source passes through an excitation modulation device to excite the material such that excitation periods are repeated at periodic intervals.
5. The carrier lifetime measurement method according to any one of claims 1 to 3, wherein excitations are intermittently applied by an excitation source to excite the material such that excitation periods are repeated at periodic intervals.
6. The carrier lifetime measurement method according to any one of claims 1 to 5, wherein the light emitted from the material is passed through a detection modulation device to separate the decaying light from the light emitted during the excitation period.

7. The carrier lifetime measurement method according to claim 6, wherein the light detecting device comprises a plurality of detector cells in an array, wherein a plurality of the decaying light emission periods are accumulated and detected by each detector cell.

8. The carrier lifetime measurement method according to claim 7, wherein the light detecting device comprises a plurality of detector cells arranged in a two dimensional array, wherein decaying light emitted from a certain region of the material is simultaneously received by each detector cell to obtain correlated information related to a position in the region and the carrier lifetime.

9. The carrier lifetime measurement method according to claim 7, wherein the light detecting device comprises a plurality of detector cells arranged in a line, and where the decaying light emitted from the material is simultaneously received by the plurality of detector cells and for which correlated information related to positions in the certain region of the material and the carrier lifetime is obtained by moving the line of detectors.

10. The carrier lifetime measurement method according to any one of claims 1 to 9, wherein the material is excited at a plurality of frequencies to obtain accumulated decaying light emission intensities from the material, where these intensities are normalized to remove the emission intensity component by computing a ratio of intensities measured at different frequencies, in order to isolate and quantify the carrier lifetime component of the intensities.

11. The carrier lifetime measurement method according to any one of claims 1 to 9, wherein a carrier lifetime component is isolated, removing the emission intensity component by taking a ratio of an intensity of the detected light obtained by accumulating the decaying periods with the intensity obtained when the material is being excited, and where the normalization intensity is obtained by continuously detecting the light emitted from the material while excitation are repeated at periodic intervals.

12. The carrier lifetime measurement method according to any one of claims 1 to 9, wherein the applied material excitation is modulated at different waveforms to obtain the accumulated decaying light intensity emitted from the material excited by individual modulation waveforms, and where the emission intensity component is removed by computing a ratio of the detected light intensities resulting from modulations with different waveforms in order to isolate the carrier lifetime component.

13. The carrier lifetime measurement method according to any one of claims 1 to 9, wherein the light emitted from the material is modulated by waveforms with different phases to obtain the accumulated decaying light intensity, and where the emission intensity component is removed by computing the ratio of the detected light intensities resulting from modulations with different phases in order to isolate the carrier lifetime component.

14. The carrier lifetime measurement method according to any one of claims 1 to 9, wherein a duty ratio of the material excitation modulation, and the duty ratio of the light detection modulation during which the decaying light is separated from the light emitted during the excitation are both made different, and where the emission intensity component is removed by computing a ratio of the detected light intensities resulting from measurements where the duty ratios are different from each other in order to isolate the carrier lifetime component.

15. The carrier lifetime measurement method according to any one of claims 1 to 14, wherein the excitation applied to the material is optical excitation.

16. The carrier lifetime measurement method according to any one of claims 1 to 14, wherein the excitation applied to the material is electrical power excitation.

17. A carrier lifetime measurement apparatus for exciting a material and detecting light emitted from that material, comprising:

- an excitation apparatus configured to excite the material such that excitation periods are repeated at periodic intervals;

- a detection modulation device configured to separate decaying light emitted after an end of the excitation period from light emitted from the material during the excitation period;

- a light detecting device configured to receive, accumulate and detect a plurality of the separated decaying light emissions within an integration time which spans a plurality of the excitation periods; and

- a central control and processing unit configured to obtain a lifetime based on an intensity of the light accumulated and detected within the integration time.

18. The carrier lifetime measurement apparatus according to claim 17, wherein the excitation apparatus includes an excitation source and an excitation modulation device for modulating an excitation emitted from the excitation source such that excitation periods are repeated at periodic intervals.
19. The carrier lifetime measurement apparatus according to claim 17, wherein the excitation apparatus includes an excitation source for emitting excitations such that excitation periods are repeated at periodic intervals.
20. The carrier lifetime measurement apparatus according to claim 18 or 19, wherein the excitation source is optical in nature.
21. The carrier lifetime measurement apparatus according to claim 18 or 19, wherein the excitation source is electrical in nature.
22. The carrier lifetime measurement apparatus according to any one of claims 17 to 19, wherein the detection modulation device is configured to split the light emitted from the material at the same time or after the end of the excitation period to obtain the decaying light.
23. The carrier lifetime measurement apparatus according to any one of claims 17 to 19, wherein the detection modulation device is configured to split the light emitted from the material partway through the excitation period to obtain the decaying light.
24. The carrier lifetime measurement apparatus according to any one of claims 17 to 19, wherein the light detecting device comprises a plurality of detector cells in an array, wherein a plurality of the decaying light emission periods are accumulated and detected by each detector cell.
25. The carrier lifetime measurement apparatus according to claim 24, wherein the light detecting device comprises a plurality of detector cells arranged in a two dimensional array, wherein the decaying light emitted from a certain region of the material is received by each of the detector cells to obtain correlated information related to a position in the region and the carrier lifetime.

26. The carrier lifetime measurement apparatus according to claim 24, wherein the light detecting device comprises a plurality of detector cells arranged in a line and a translation motion device is provided for changing the position of the light detecting device relative to the material in a direction normal to the line, wherein the decaying light emitted from the material is simultaneously received by the plurality of detector cells and for which correlated information related to a position in the certain region and the carrier lifetime is obtained by moving the line of detectors.

27. The carrier lifetime measurement apparatus according to any one of claims 17 to 19, wherein a wavelength filter is positioned between the material and the detection apparatus.

28. The carrier lifetime measurement apparatus according to any one of claims 17 to 19, wherein a polarization filter is positioned between the material and the detection apparatus.

29. The carrier lifetime measurement apparatus according to any one of claims 17 to 19, wherein the excitation apparatus is capable of changing the frequency of the excitation applied to the material, and the central control and processing unit is configured to normalize the signal obtained by the light detecting device to remove the emission intensity component, in order to isolate the carrier lifetime component by computing the ratio of detected light intensities resulting from excitations at different frequencies.

30. The carrier lifetime measurement apparatus according to any one of claims 17 to 19, wherein the excitation apparatus is capable of exciting the material such that excitation periods are repeated at periodic intervals, and the central control and processing unit is configured to normalize the signal obtained by the light detecting device to remove the emission intensity component, in order to isolate the carrier lifetime component by computing the ratio of detected light intensities resulting from measurements as described above to light intensities resulting from continuous detection of the light emitted from the material.

31. The carrier lifetime measurement apparatus according to any one of claims 17 to 19, wherein the light detecting device is capable of modulating, detecting and accumulating the decaying light emissions for which the excitations applied to the material

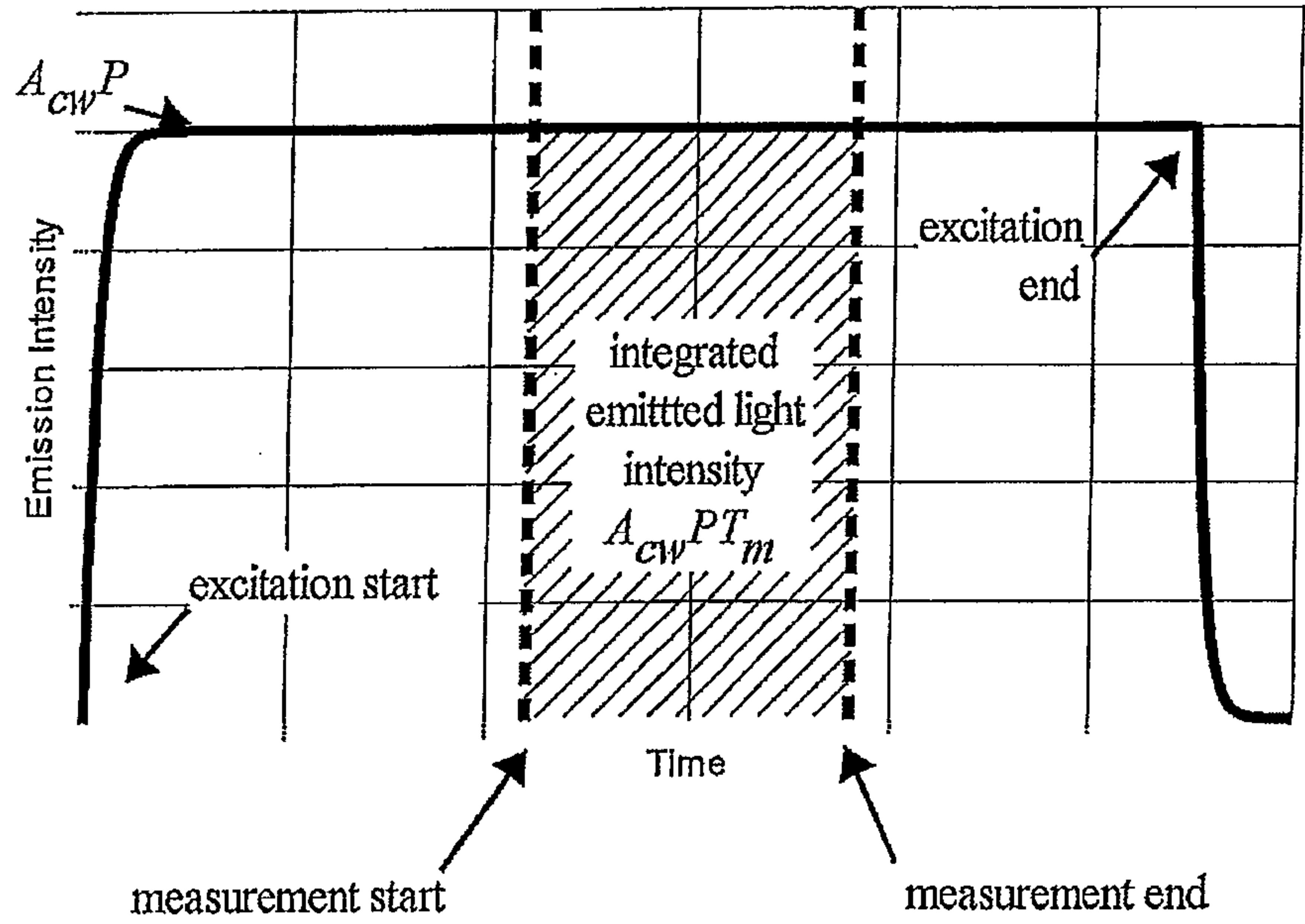
have been modulated by different waveforms, and the central control and processing unit is configured to normalize the signal obtained by the light detecting device to remove the emission intensity component, by computing the ratio of detected light intensities resulting from modulations with different waveforms.

32. The carrier lifetime measurement apparatus according to any one of claims 17 to 19, wherein the detection modulation device is capable of modulating the light emitted from the material by waveforms at different phases, and the light detecting device is capable of accumulating and detecting the decaying light emissions, and the central control and processing unit is configured to normalize the signal obtained by the light detecting device to remove the emission intensity component, by computing the ratio of detected light intensities resulting from modulations with waveforms at different phases.

33. The carrier lifetime measurement apparatus according to any one of claims 17 to 19, wherein the excitation apparatus is capable of changing a duty ratio of the periodic excitations applied to the material, and the detection modulation device is capable of changing its duty ratio of the period during which the decaying light is separated from the light emitted during the excitation period, and the central control and processing unit is configured to normalize the signal obtained by the light detecting device to remove the emission intensity component, by computing the ratio of detected light intensities resulting from modulations with waveforms of different duty ratios.

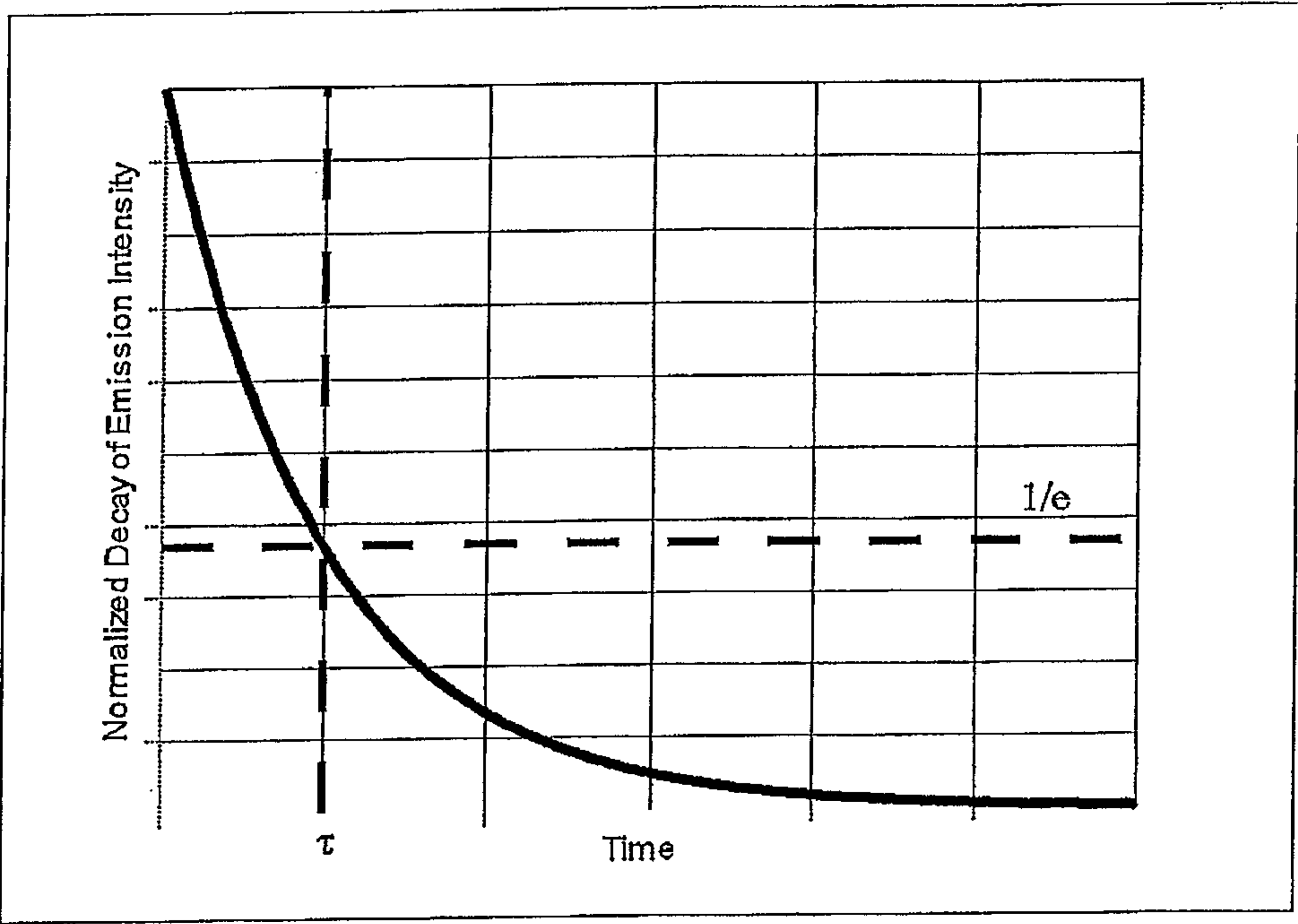
[圖1]

Fig. 1



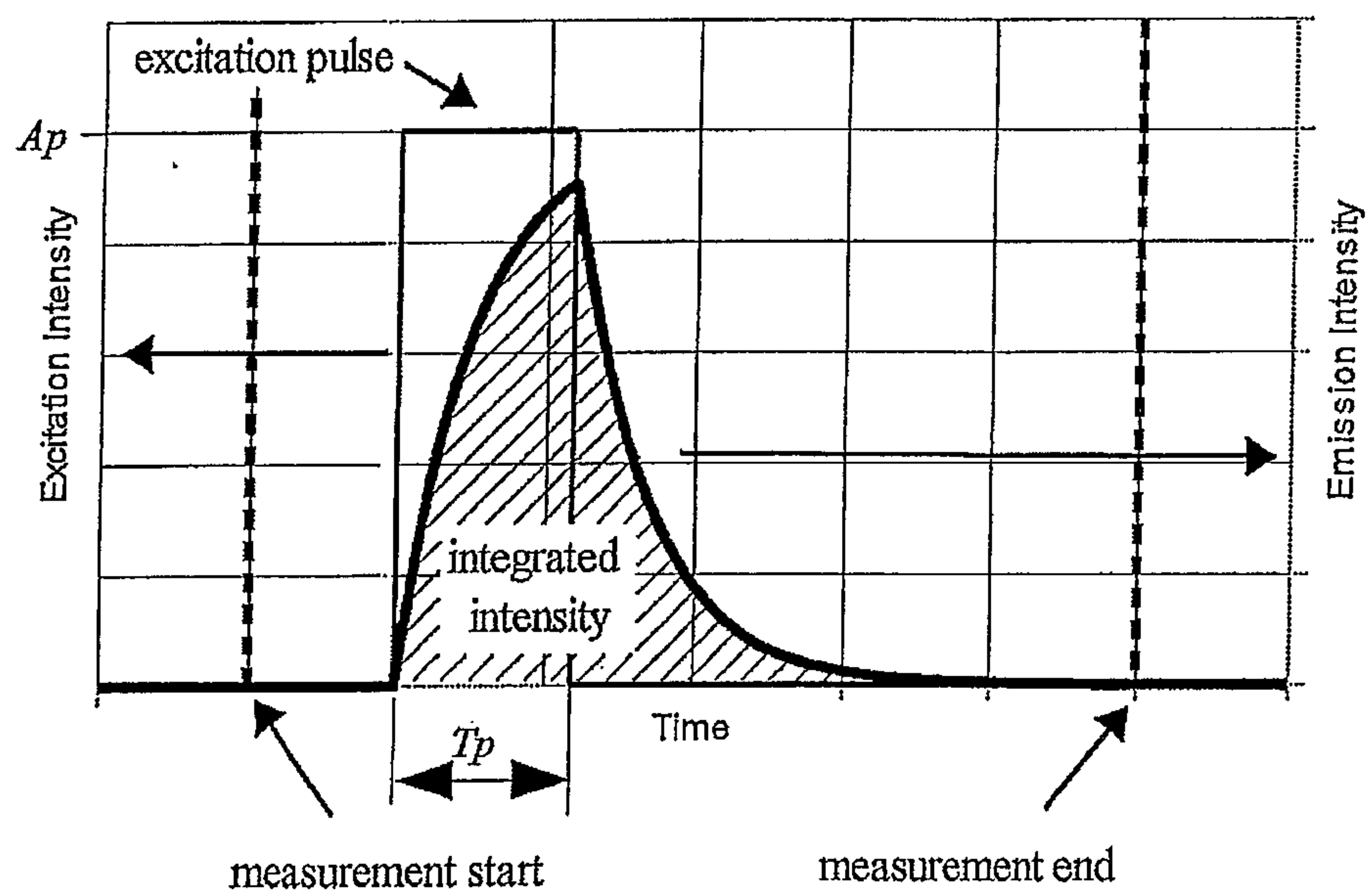
[圖2]

Fig. 2



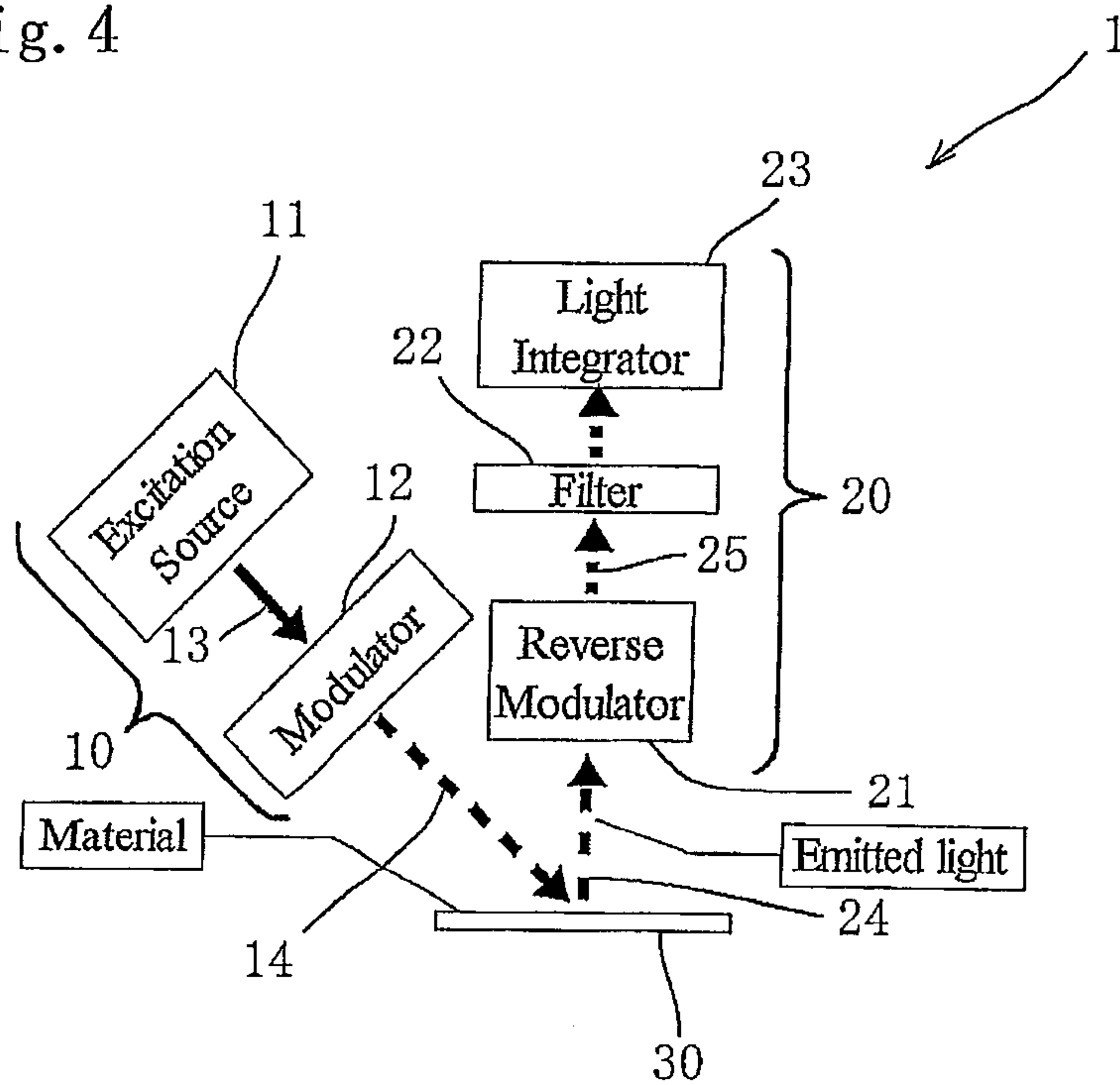
[図3]

Fig. 3



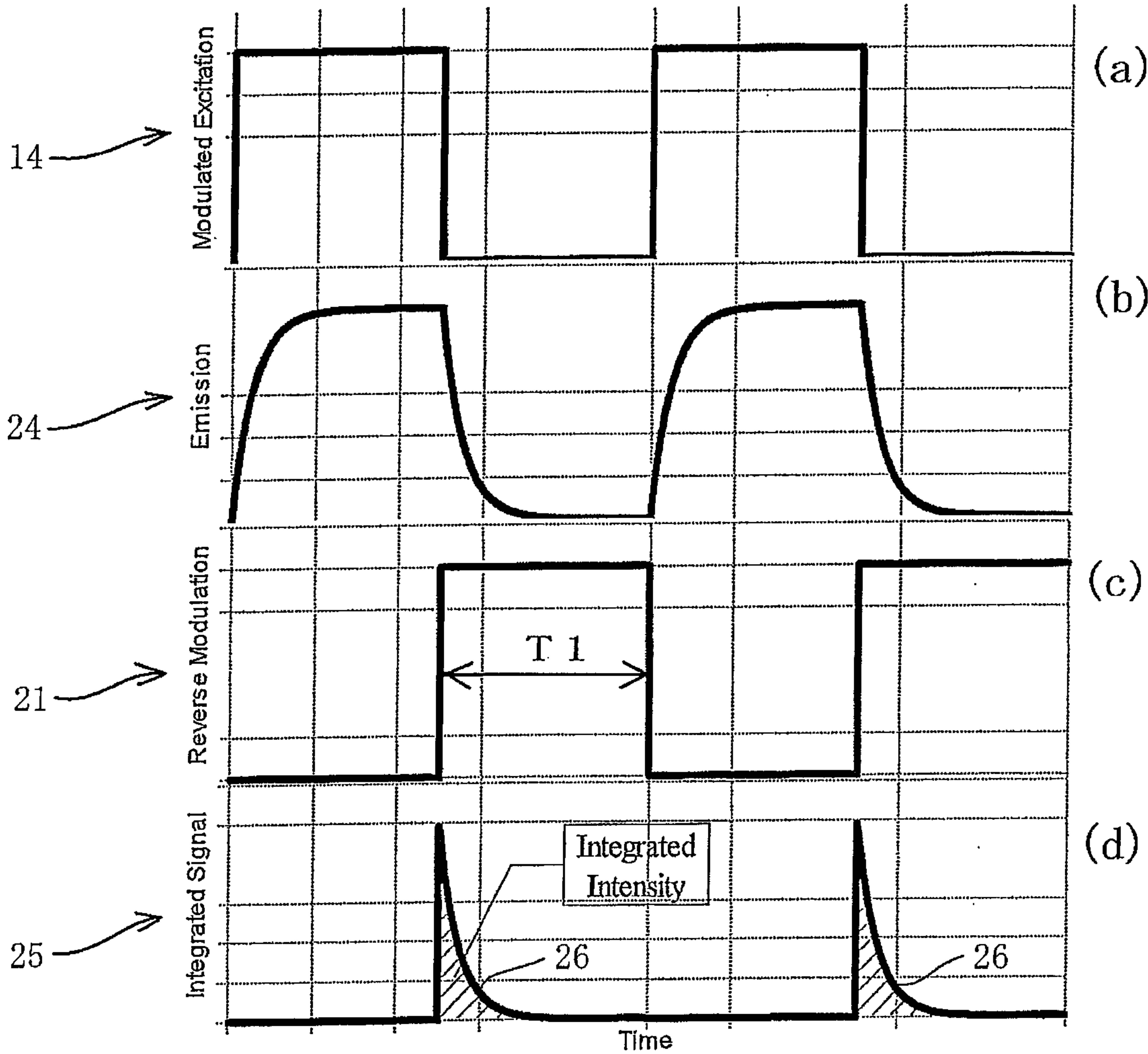
[図4]

Fig. 4



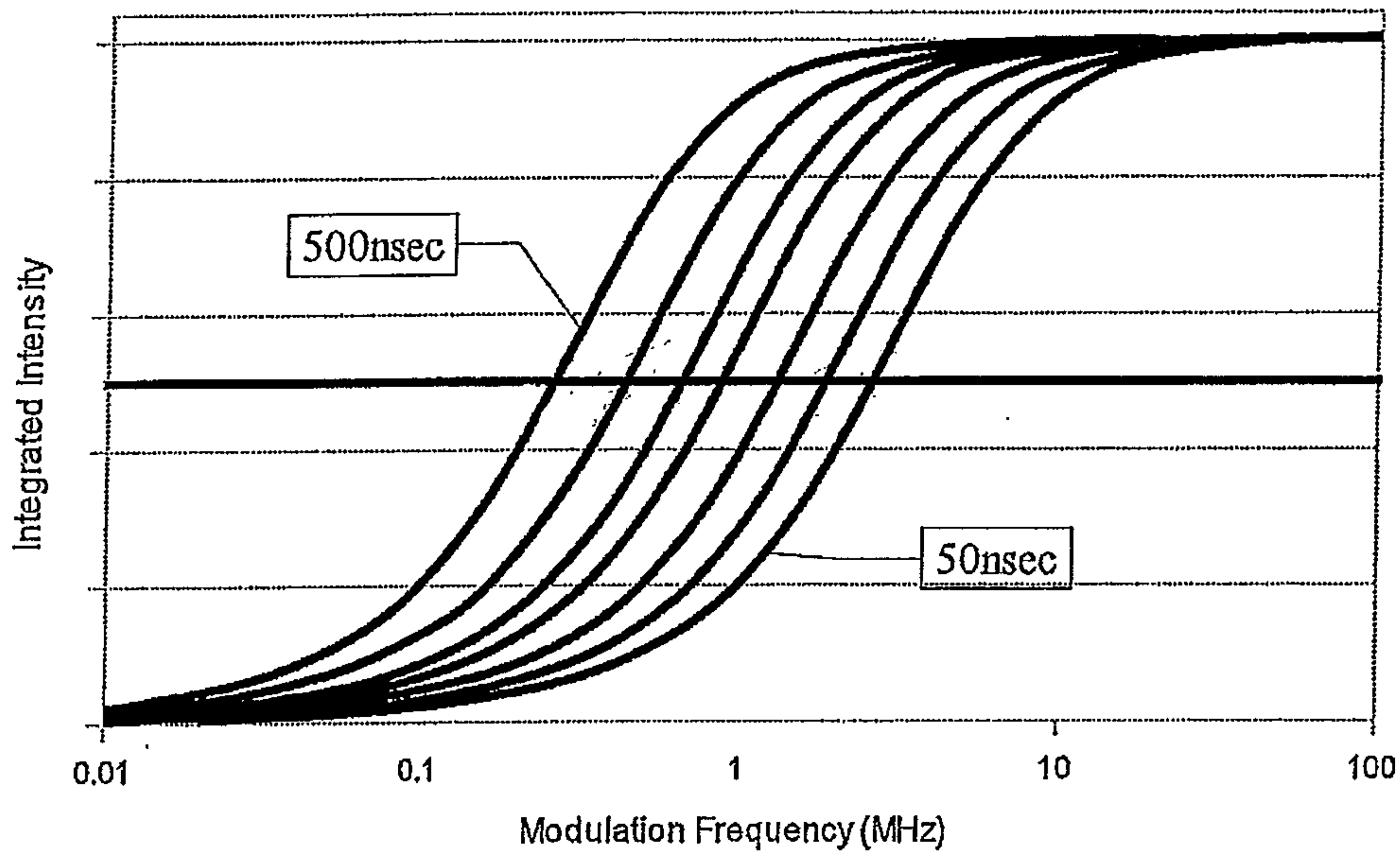
[圖5]

Fig. 5



[図6]

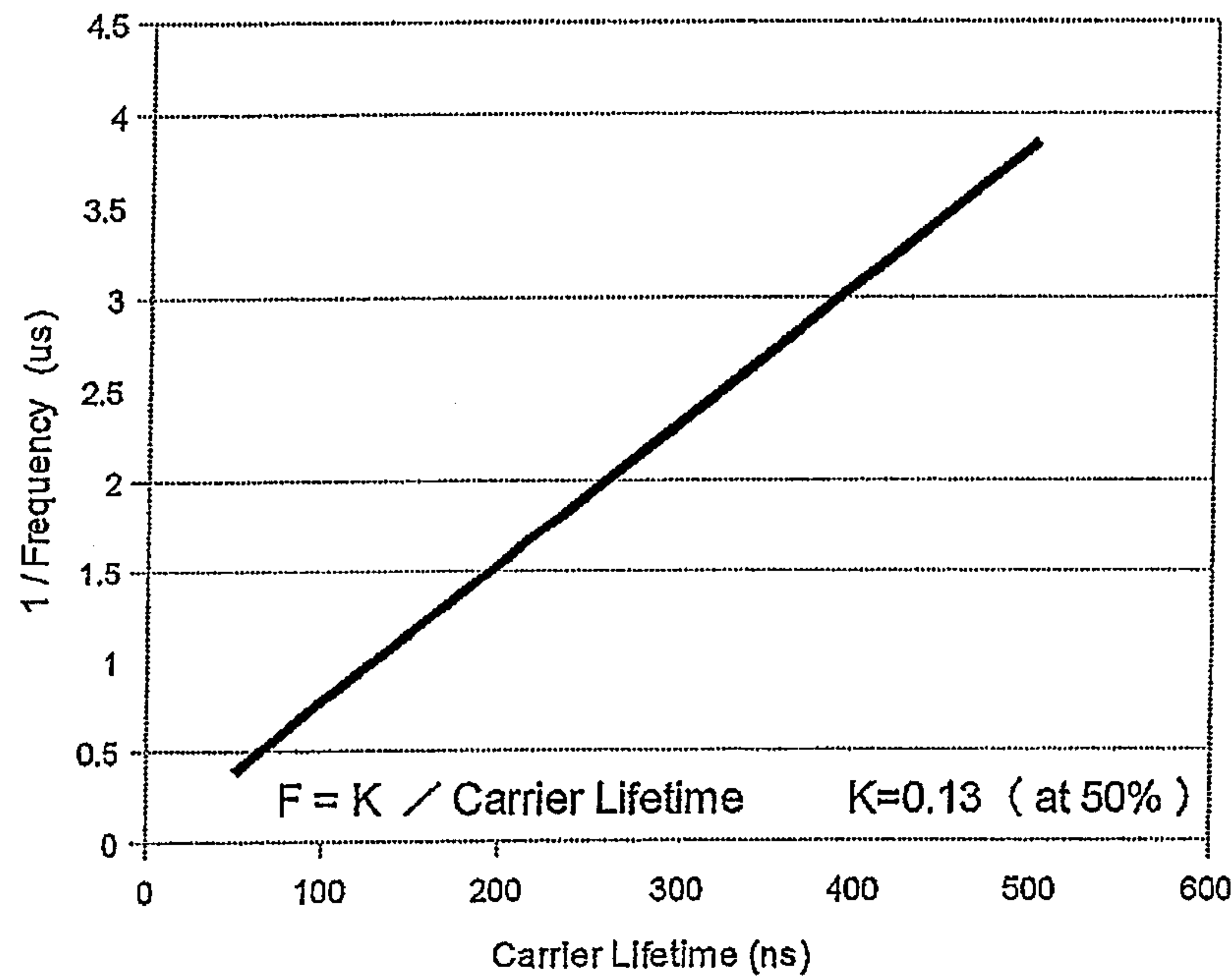
Fig. 6



[図7]

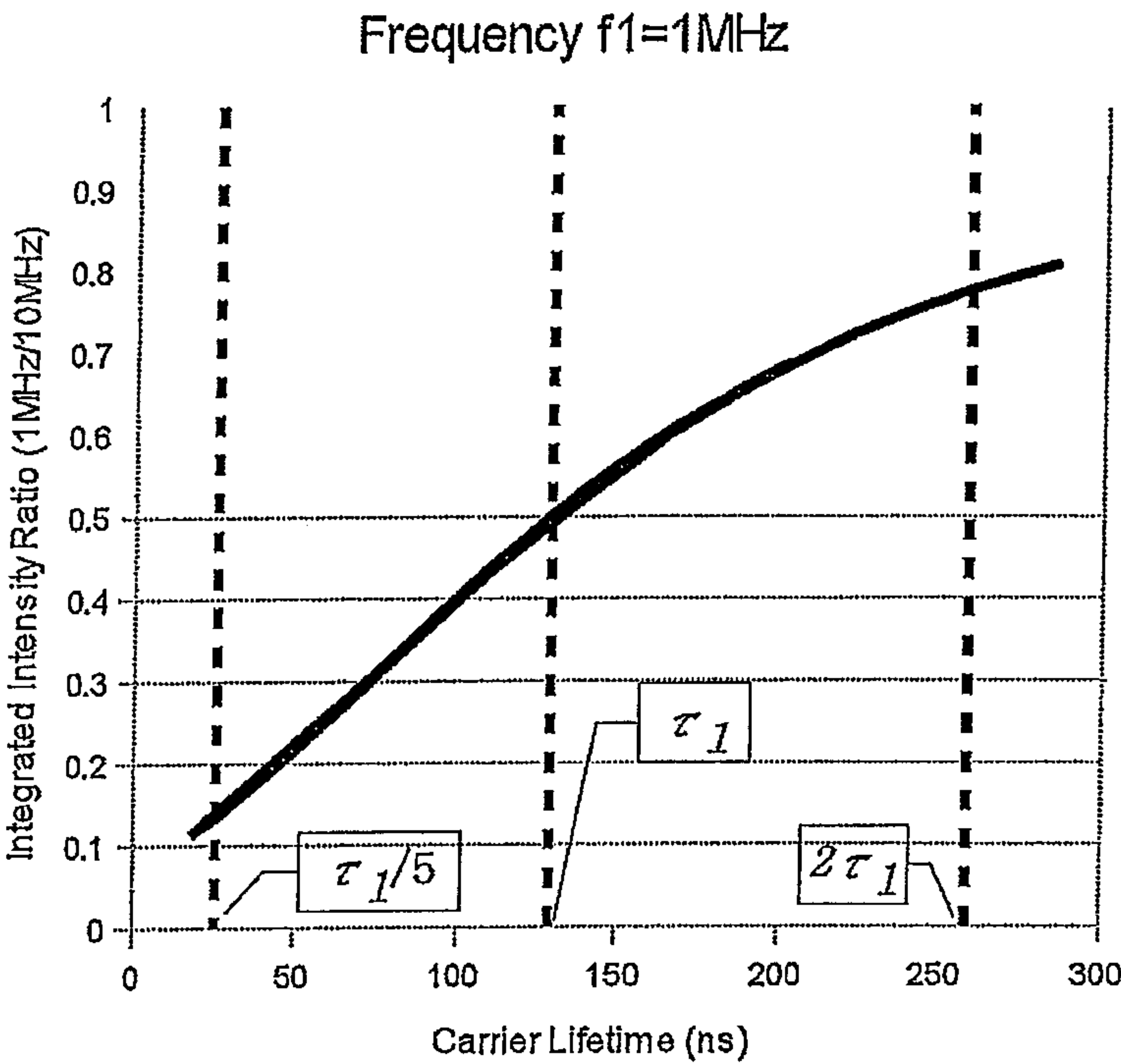
Fig. 7

Dependence of 50% maximum integrated intensity on lifetime



[圖8]

Fig. 8

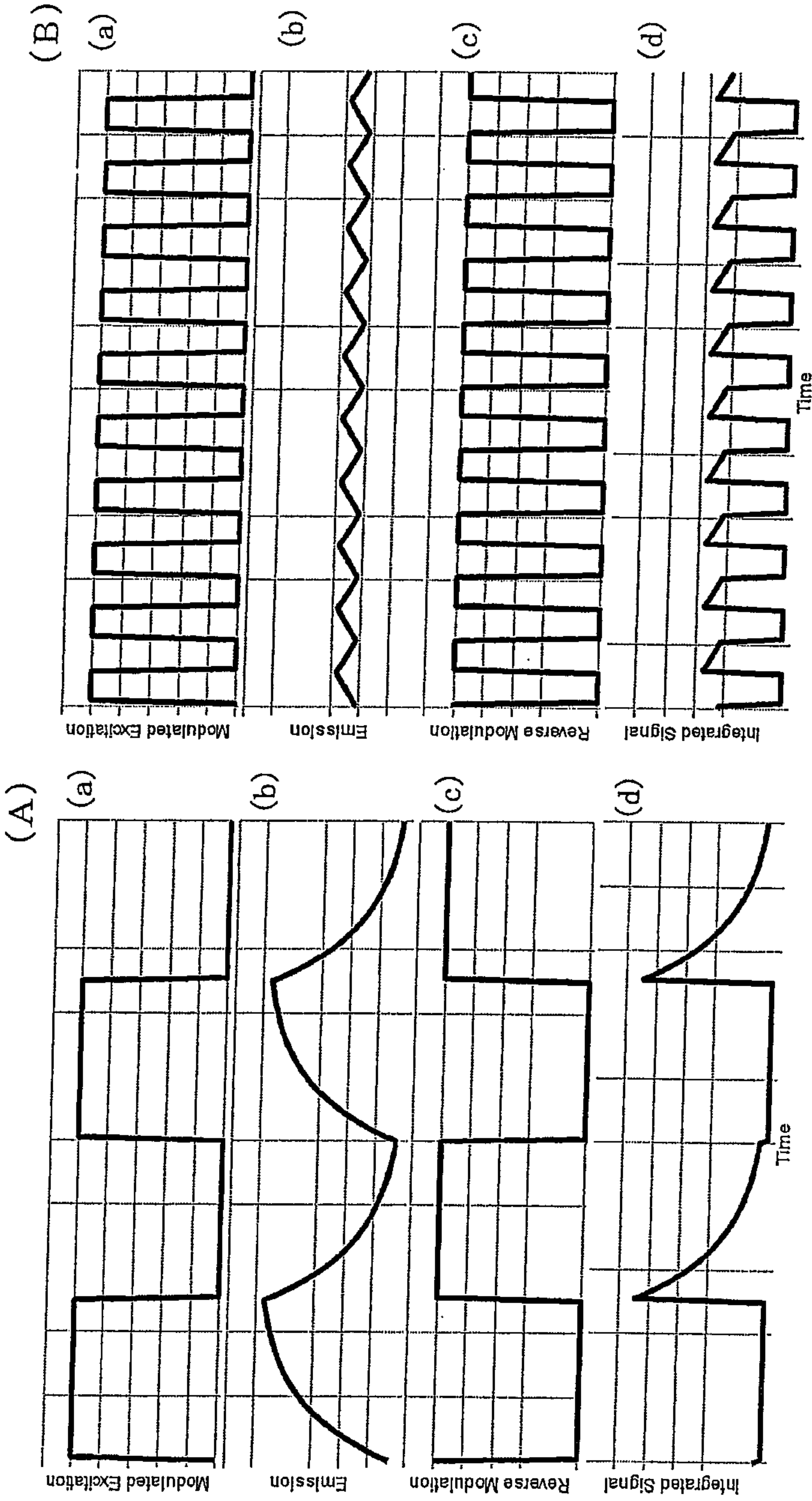


[圖9]

Fig. 9

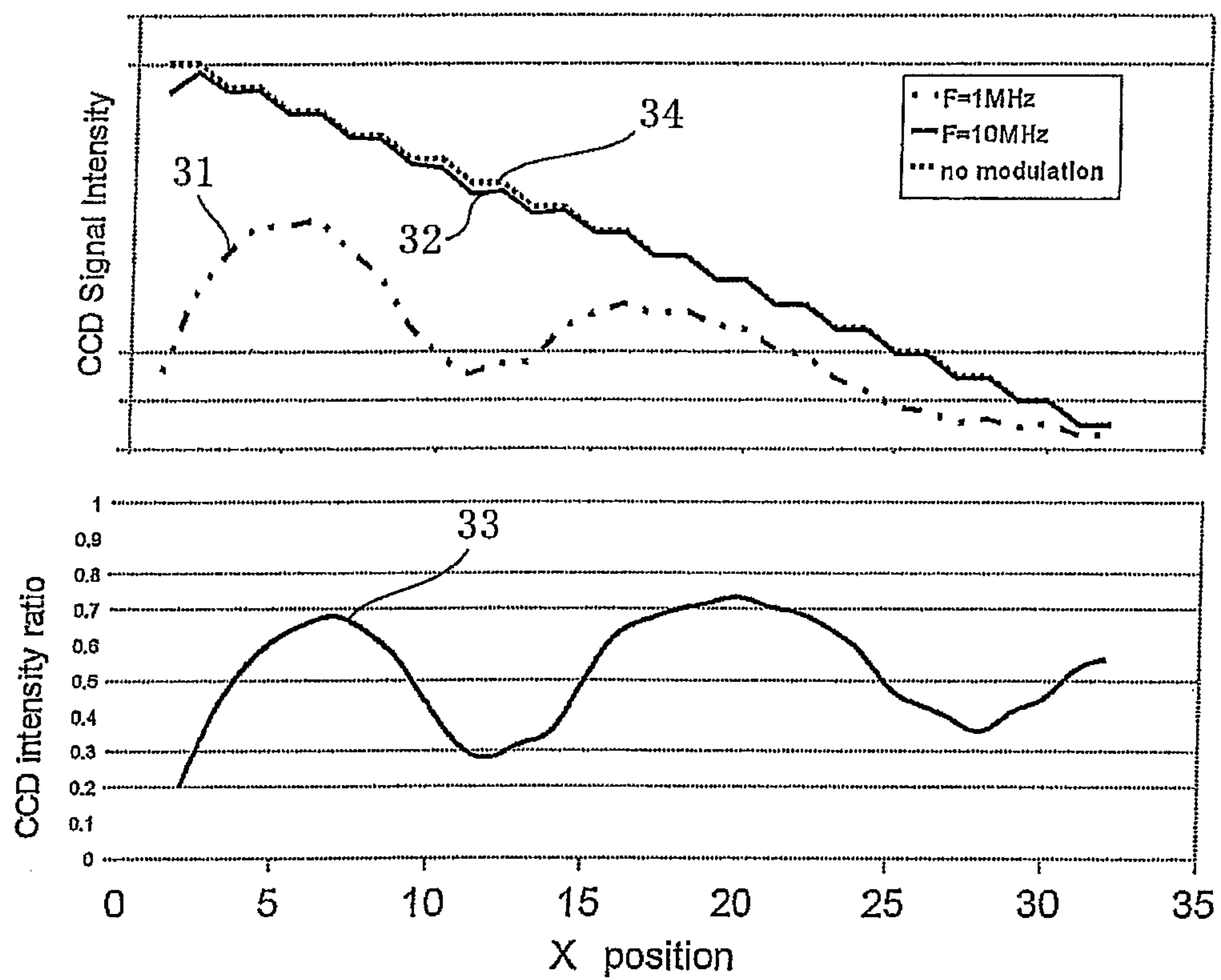


Fig. 10 [圖10]



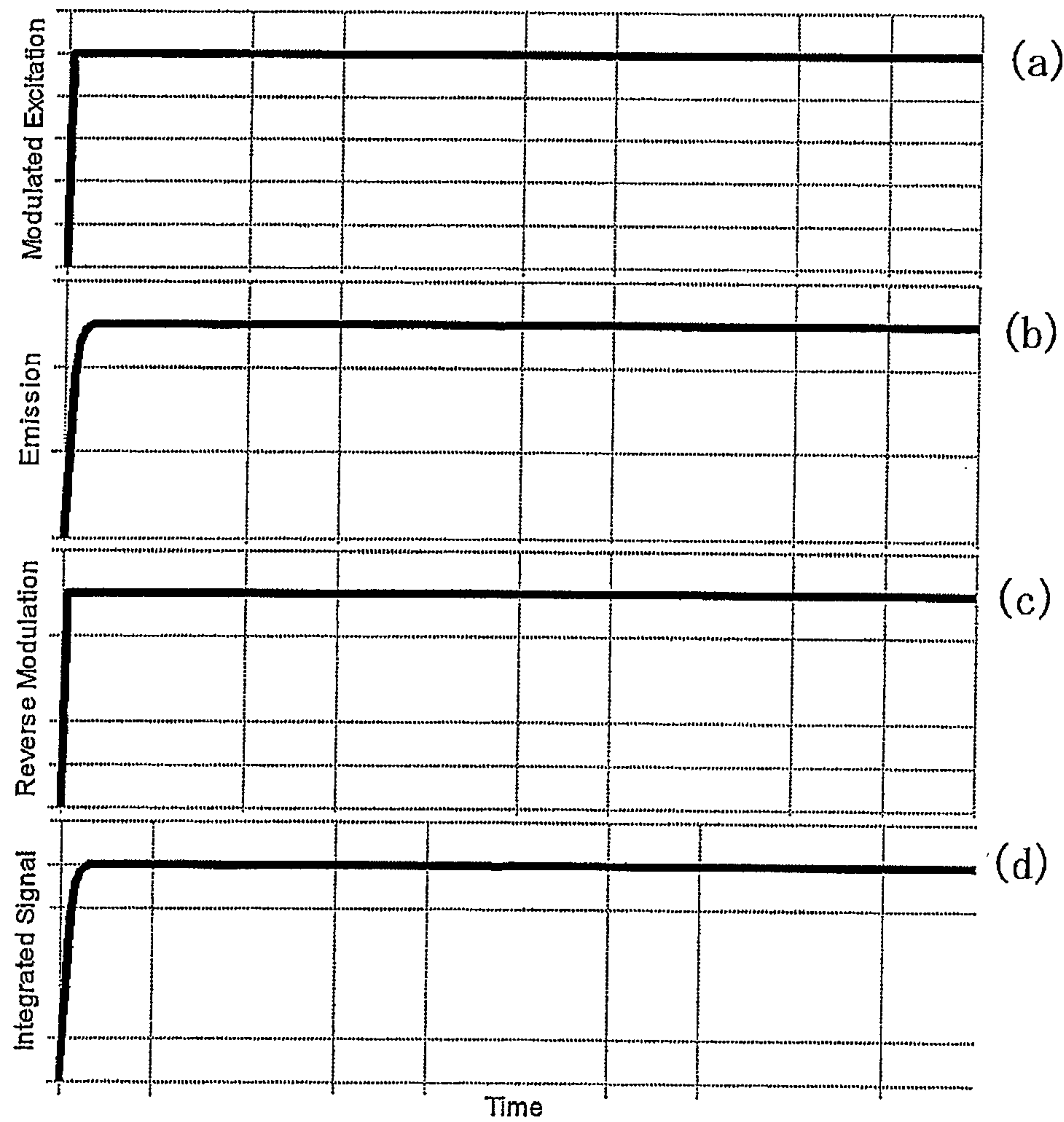
[圖11]

Fig. 11



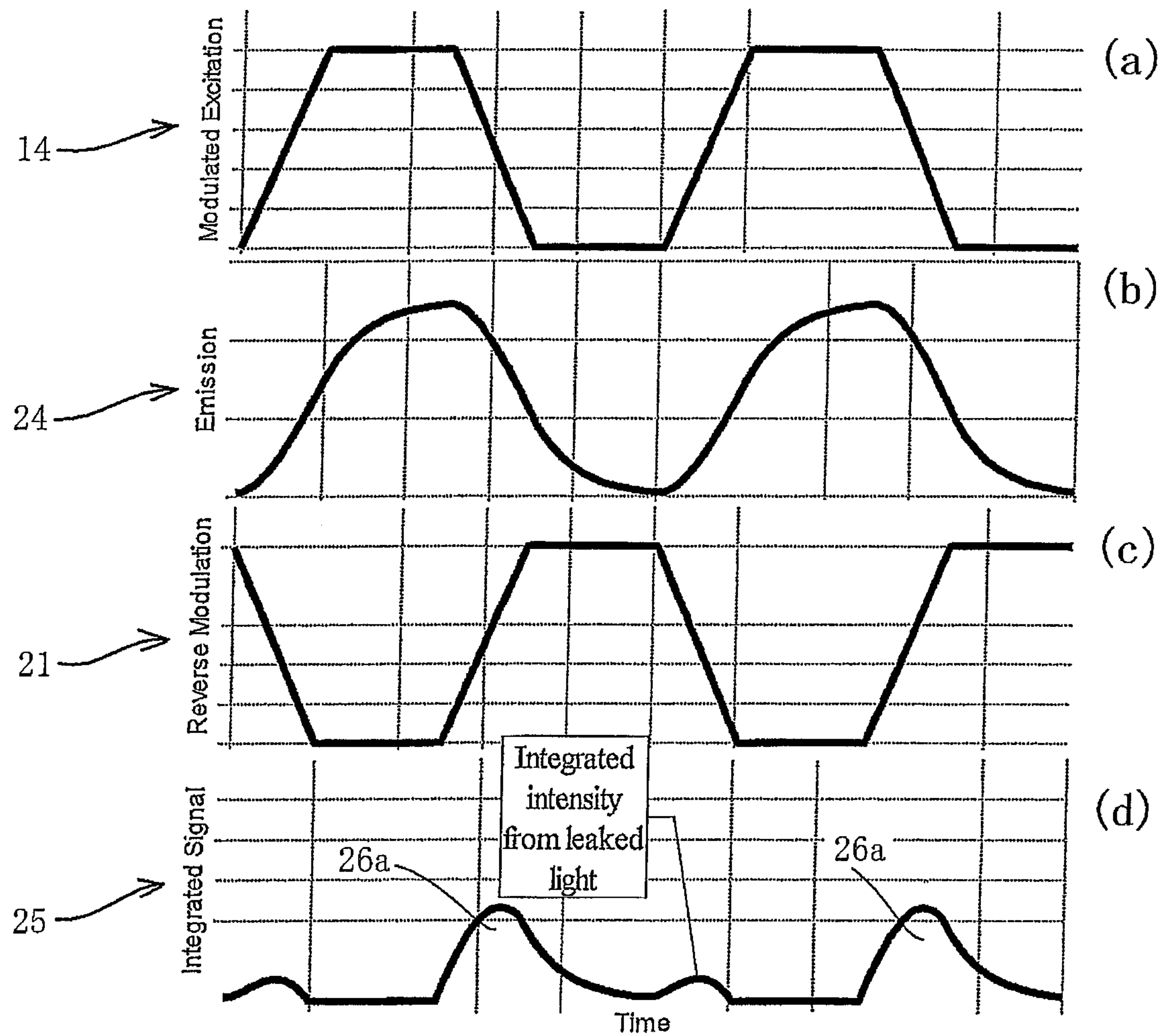
[圖12]

Fig. 12



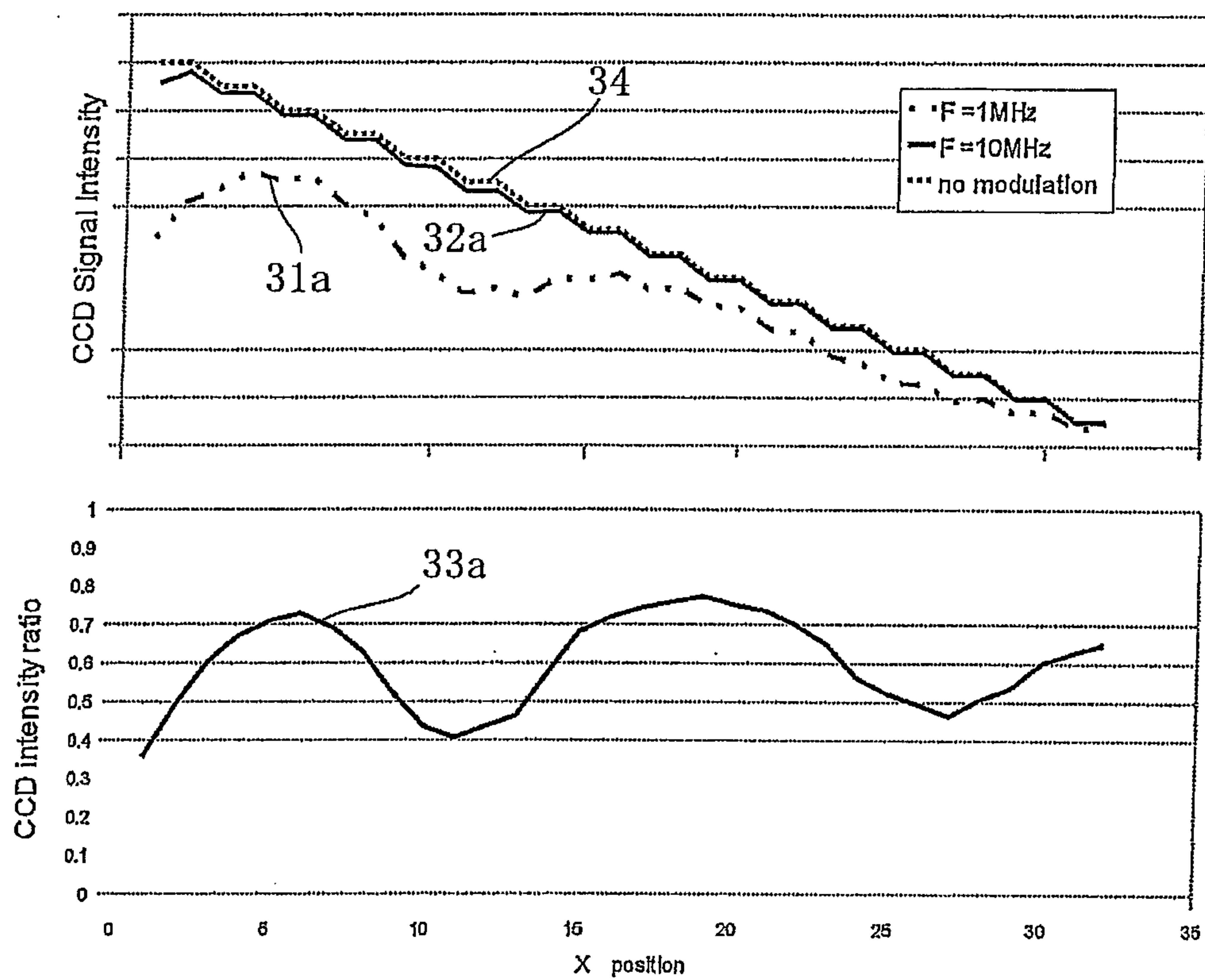
[圖13]

Fig. 13



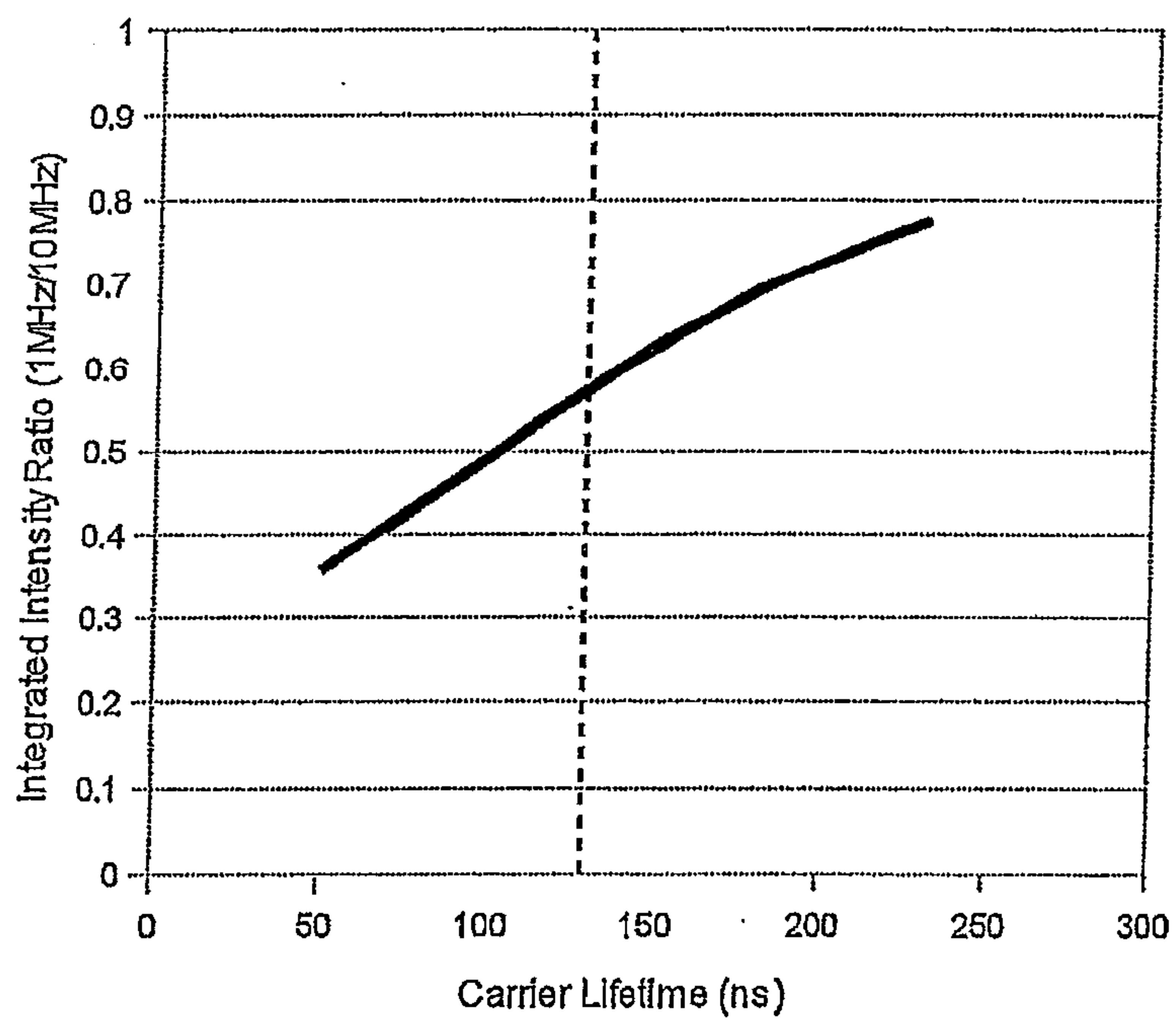
[圖14]

Fig. 14

*non-ideal case of Illustration 10*

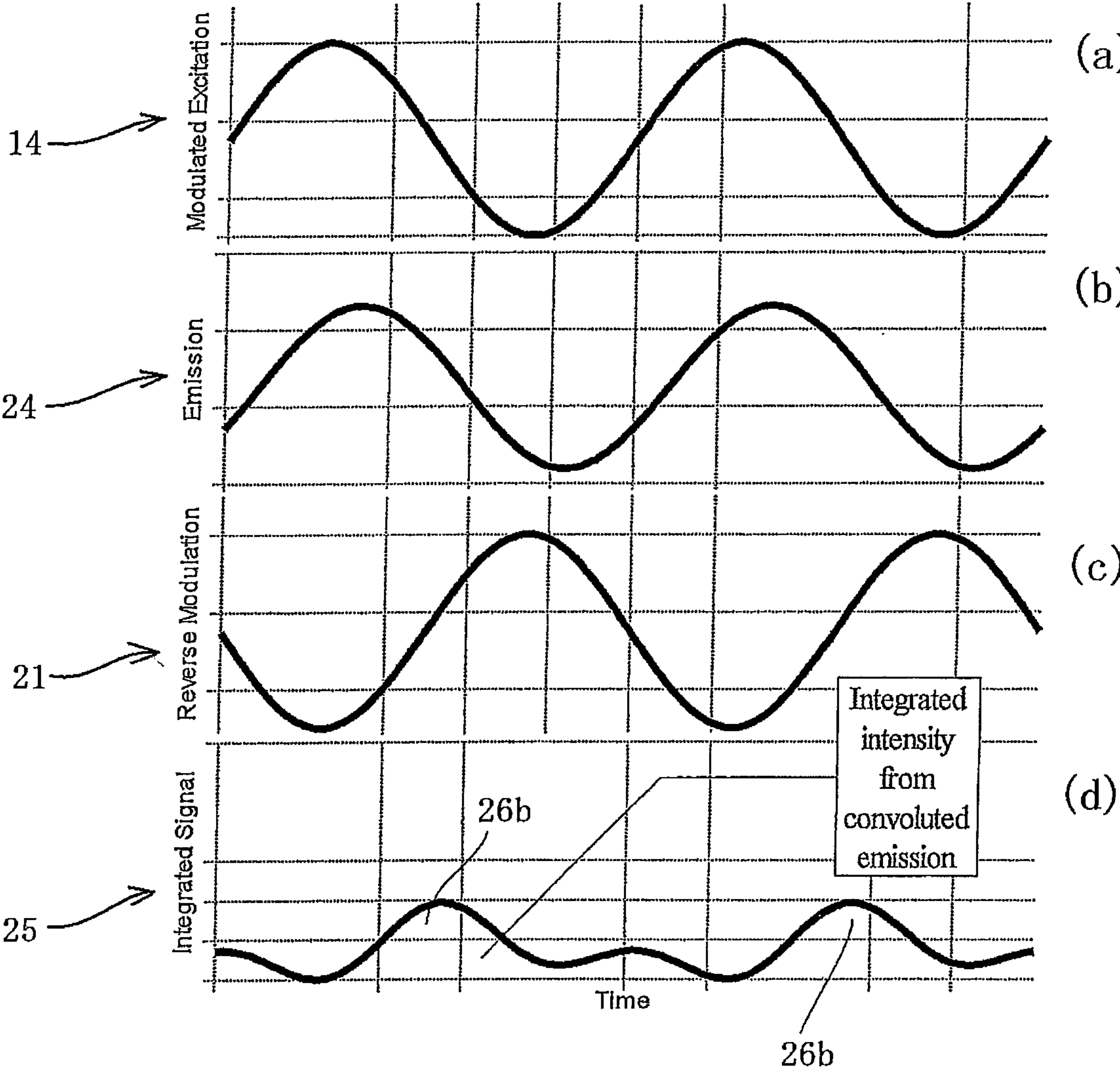
[圖15]

Fig. 15

Frequency $f_1=1\text{MHz}$ 

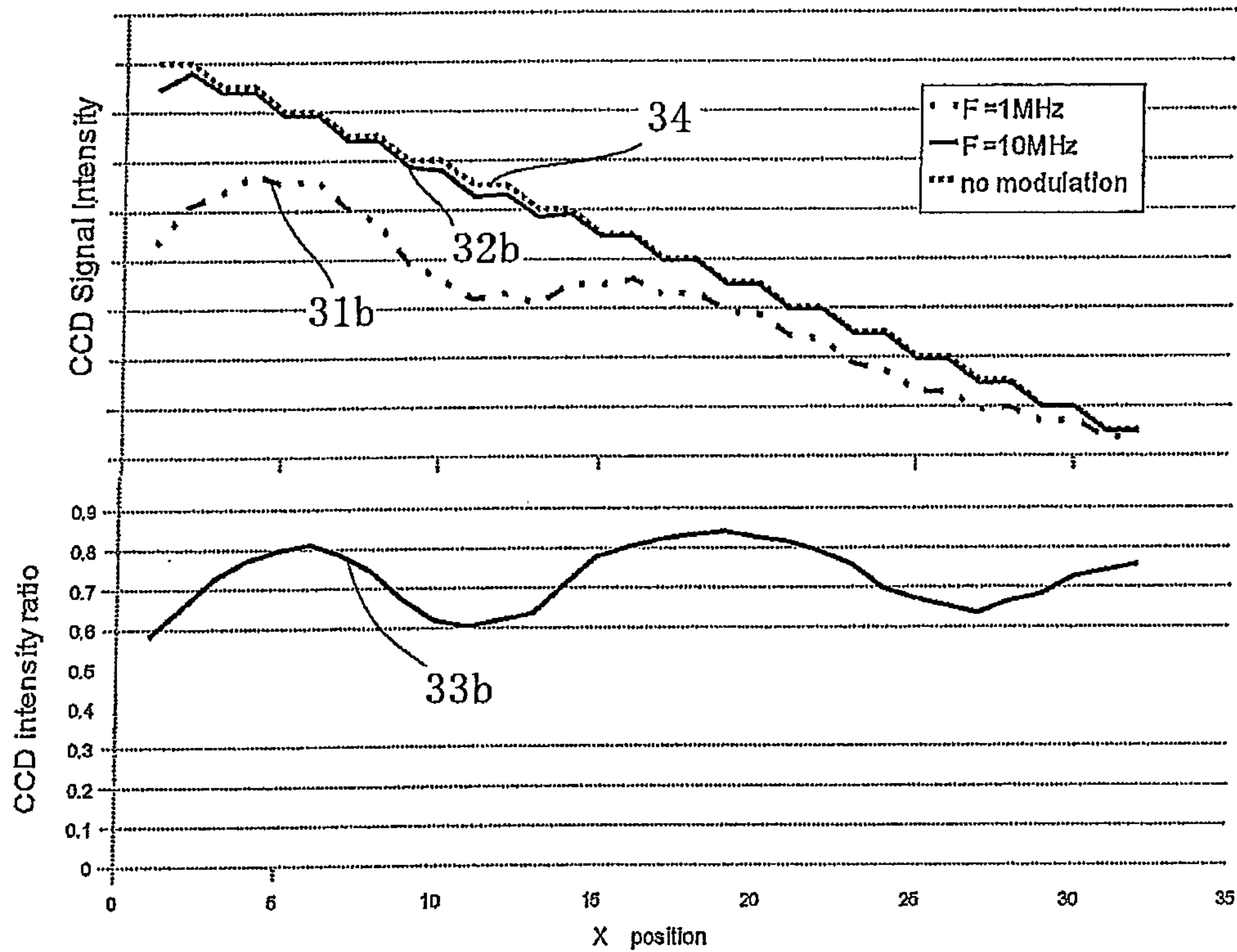
[圖16]

Fig. 16



[圖17]

Fig. 17



[圖18]

Fig. 18

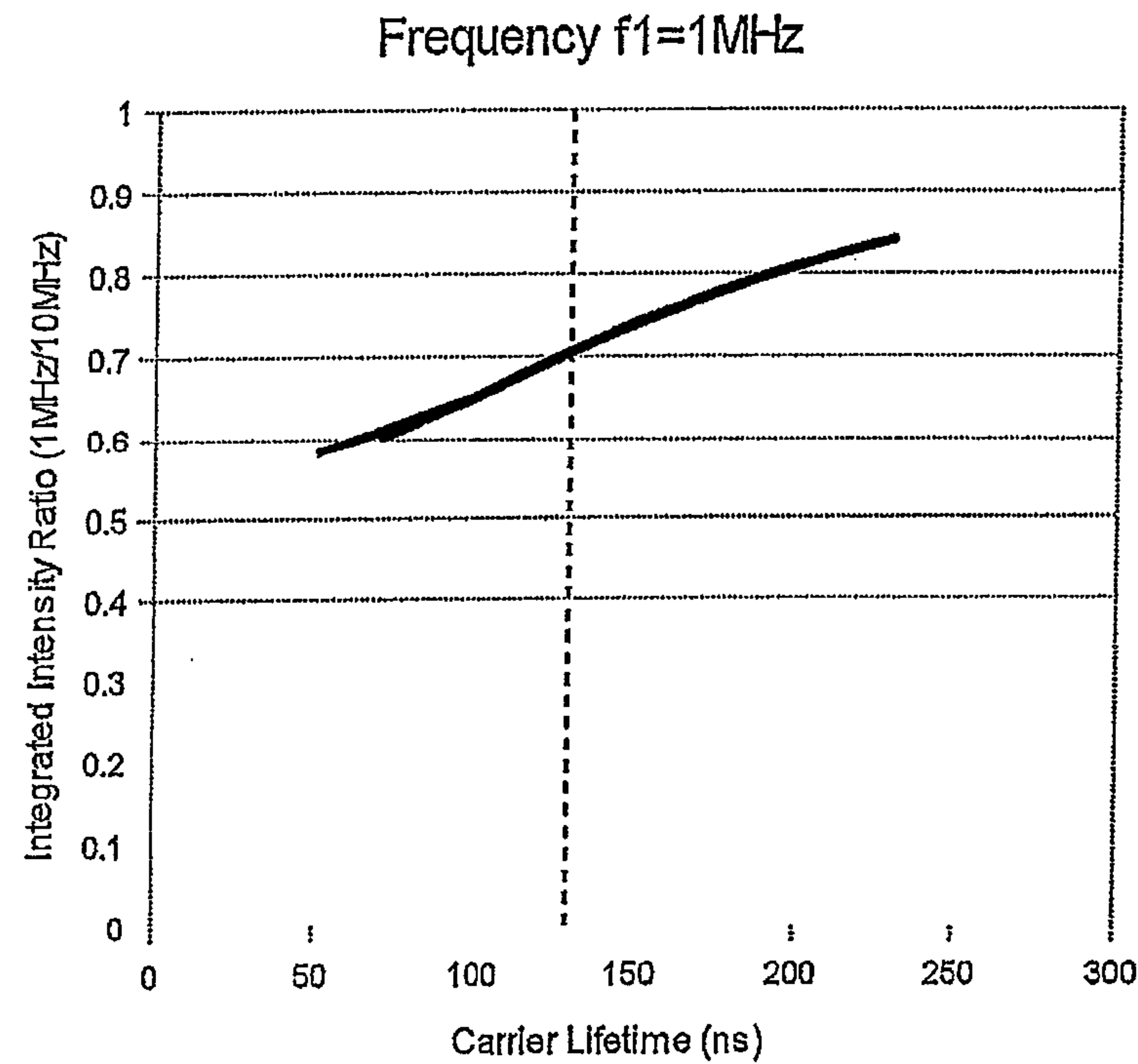
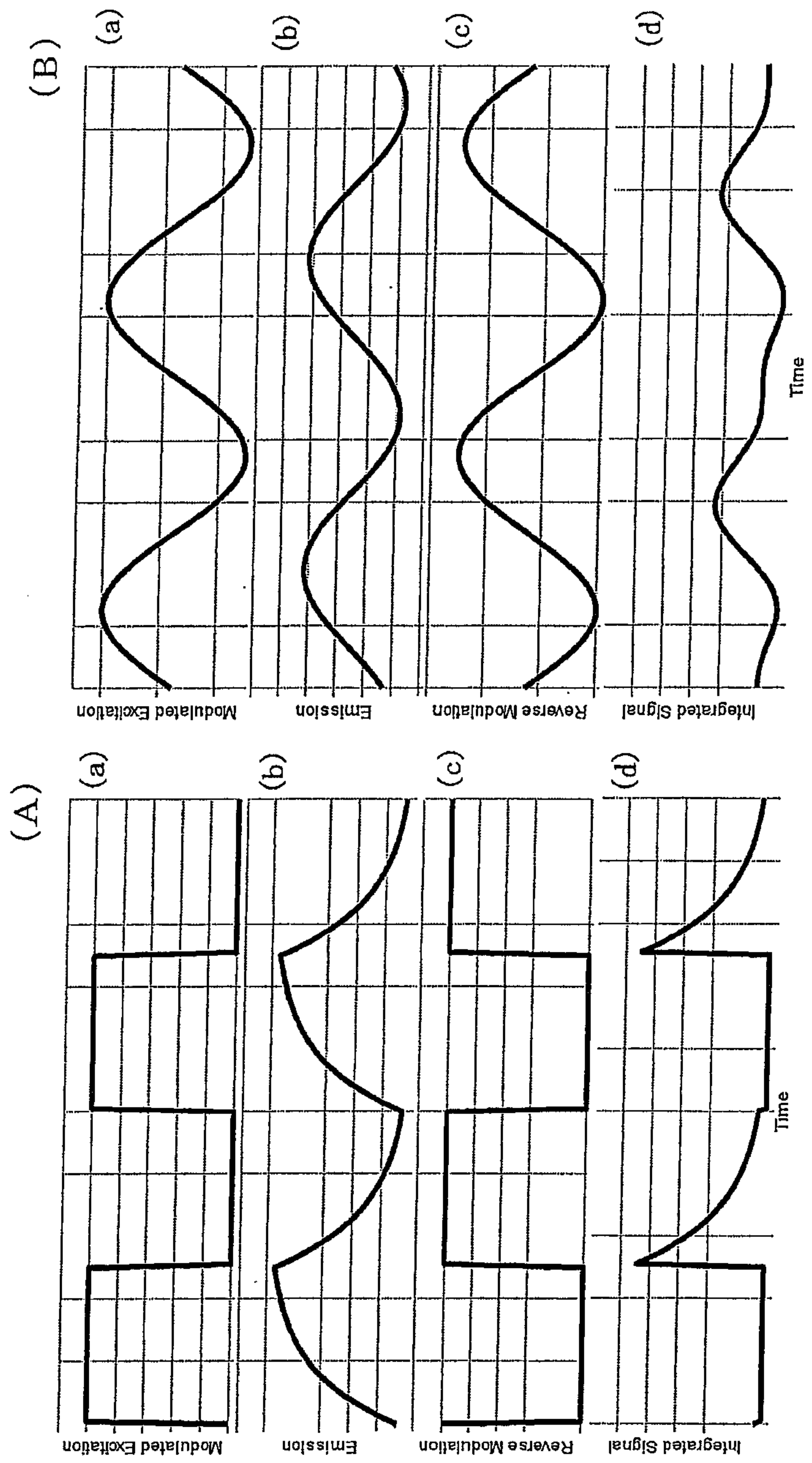
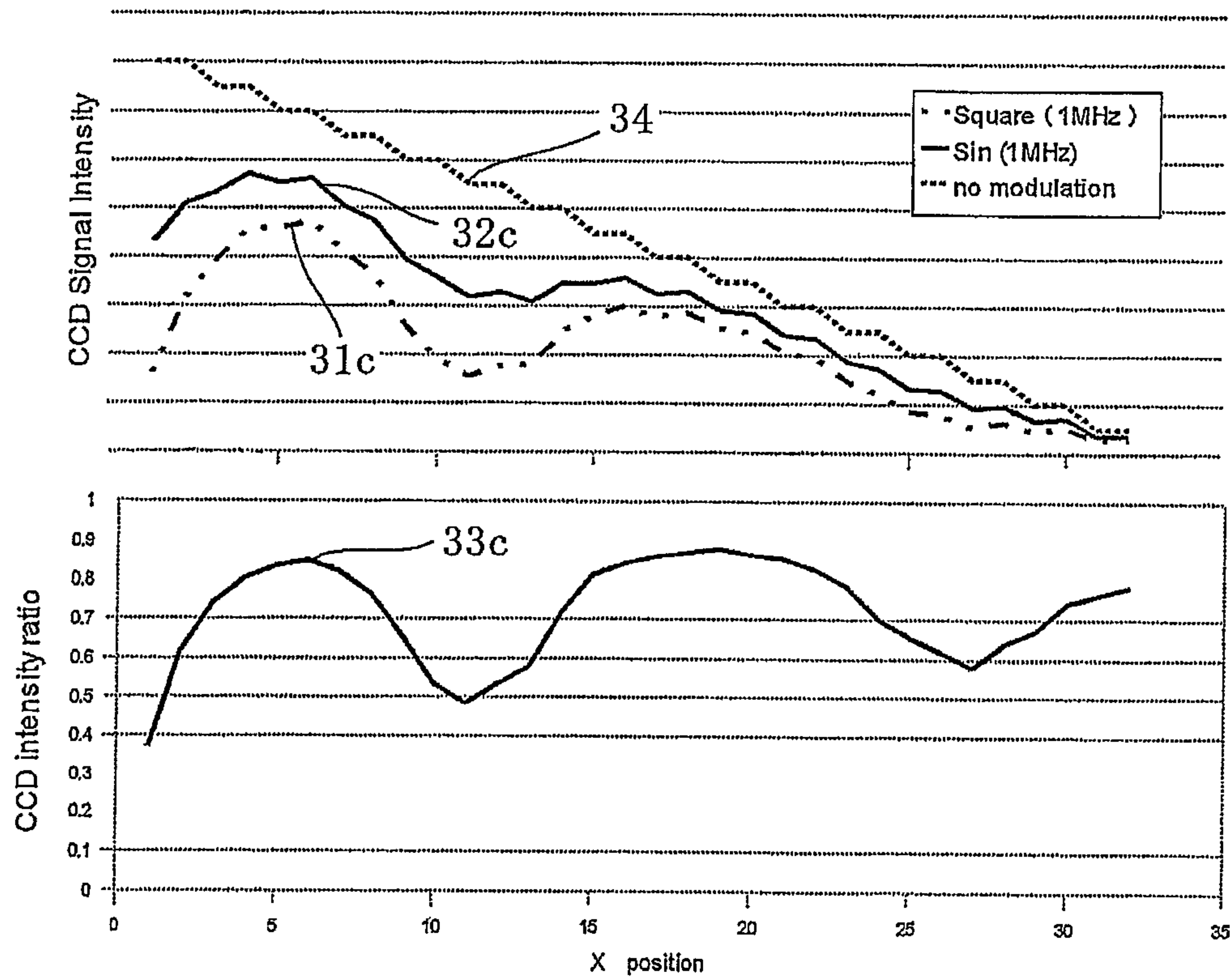


Fig. 19 [19]



[圖20]

Fig. 20



[圖21]

Fig. 21

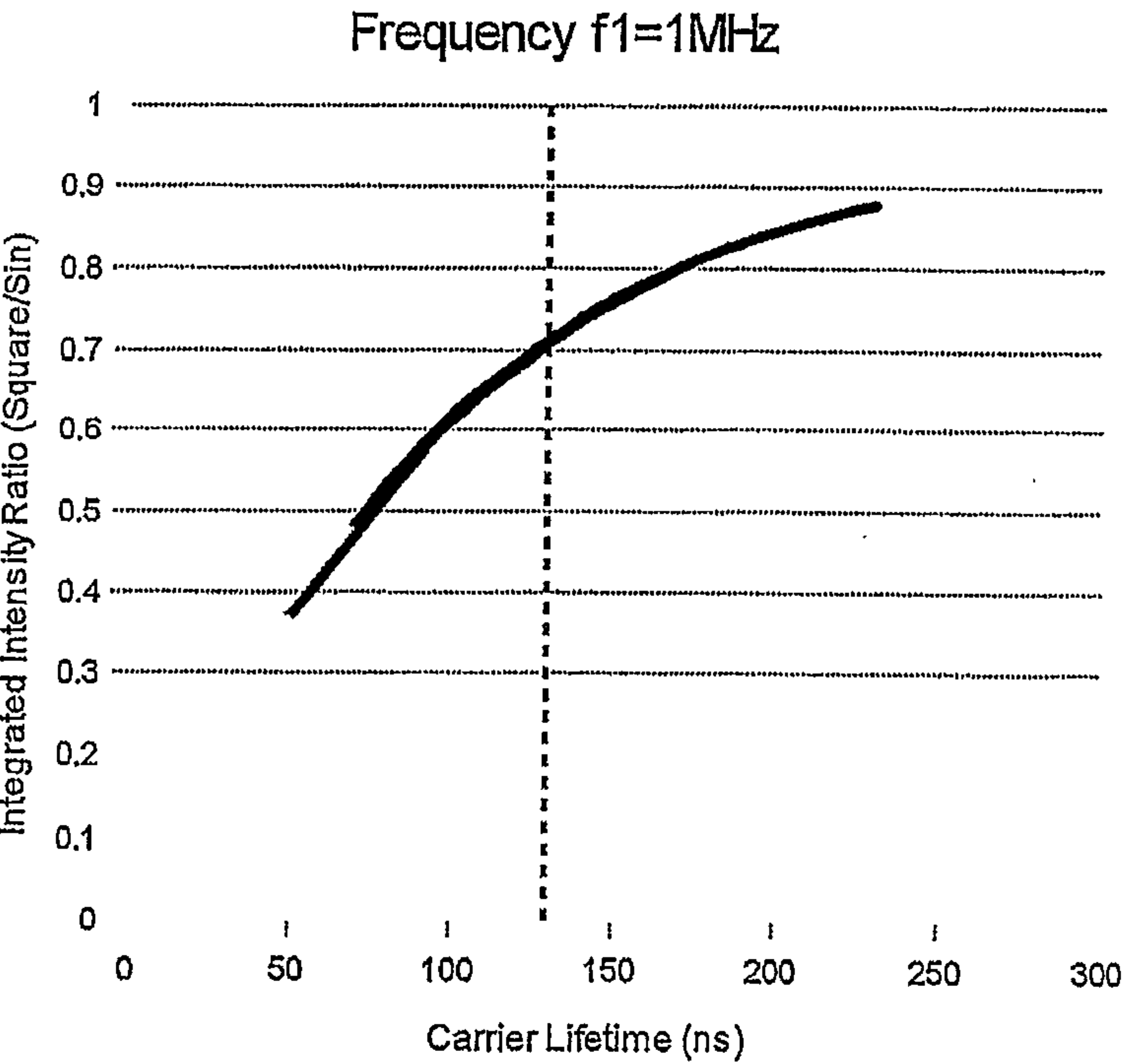
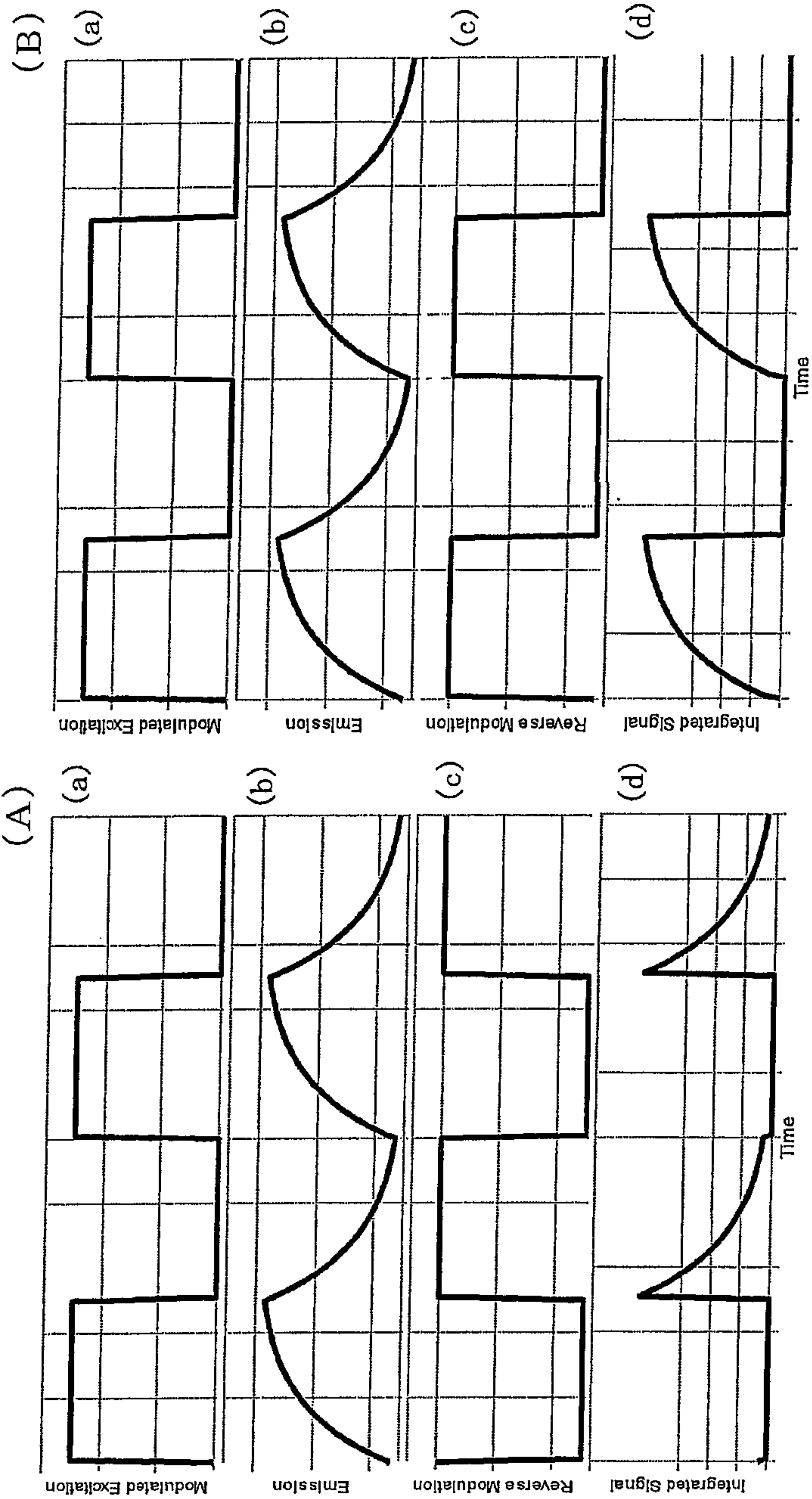
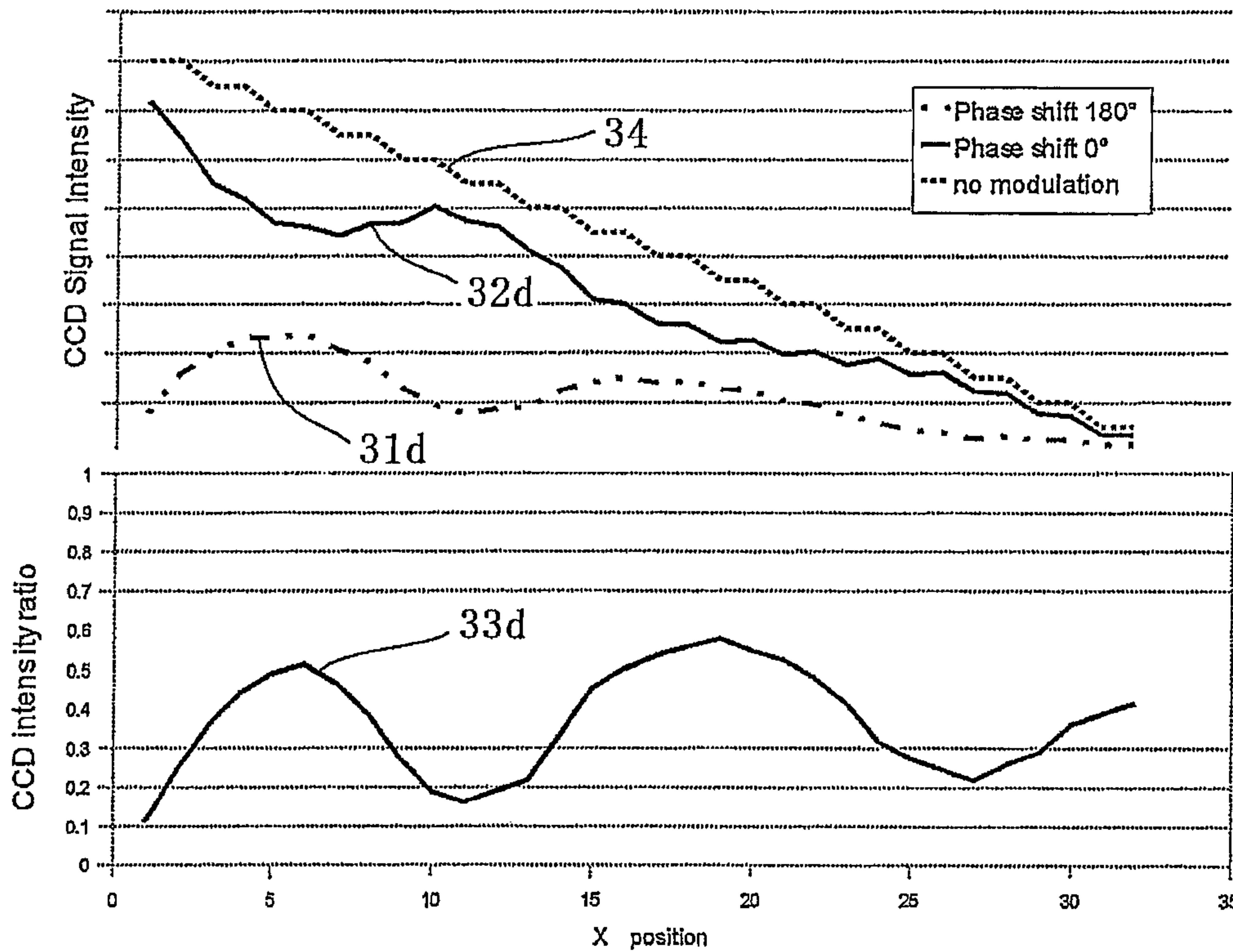


Fig. 22 [22]



[圖23]

Fig. 23



[圖24]

Fig. 24

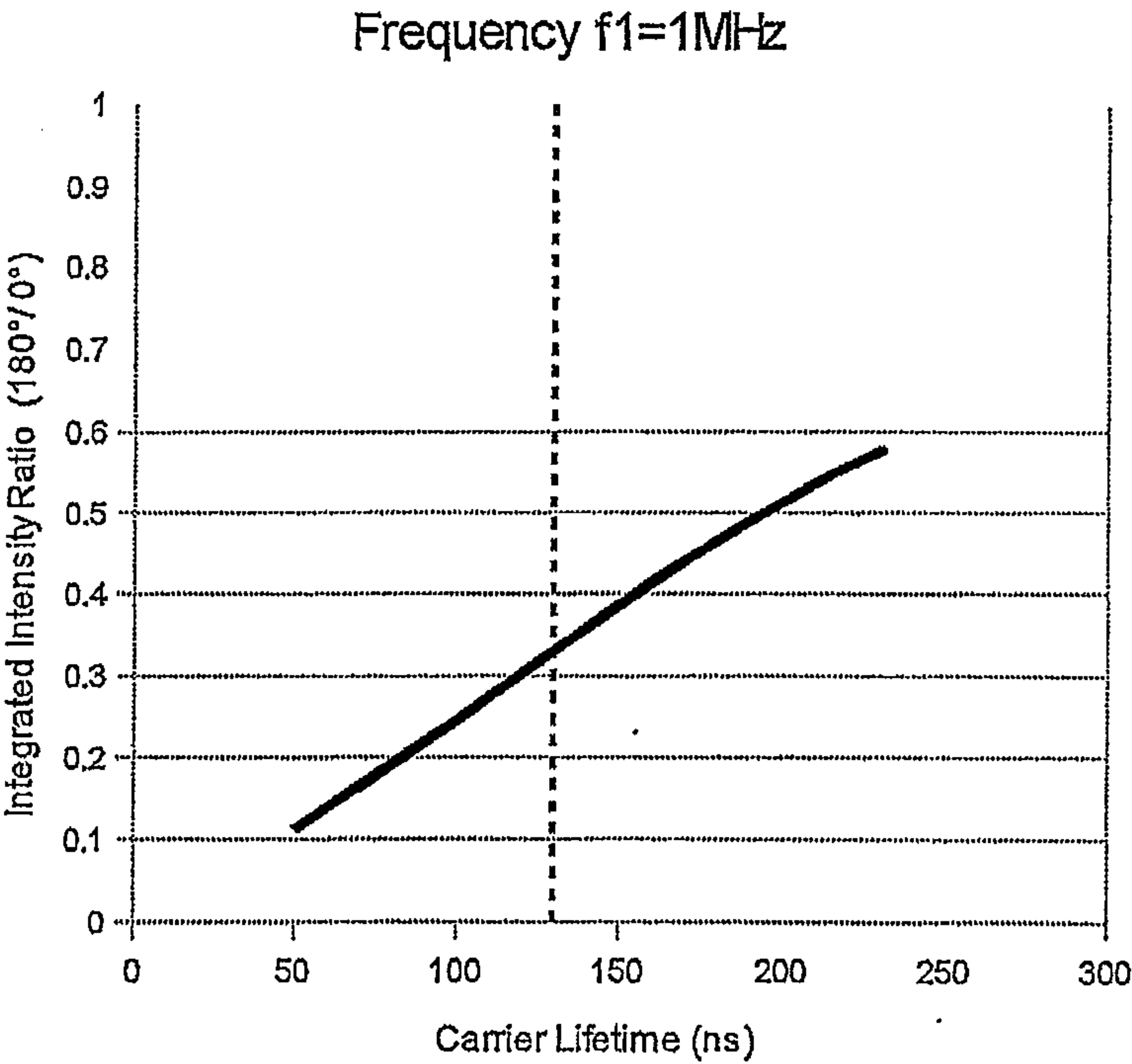
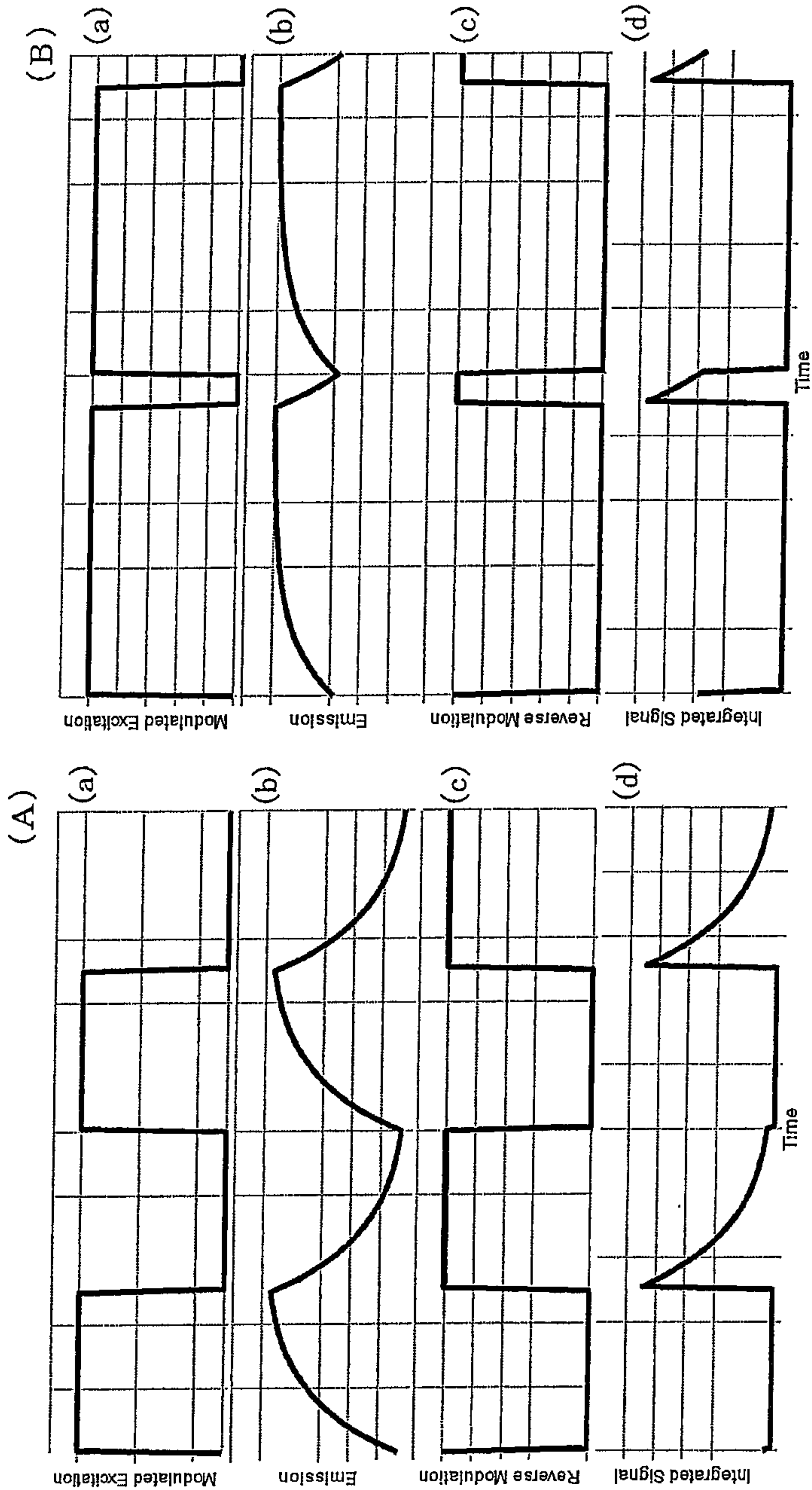
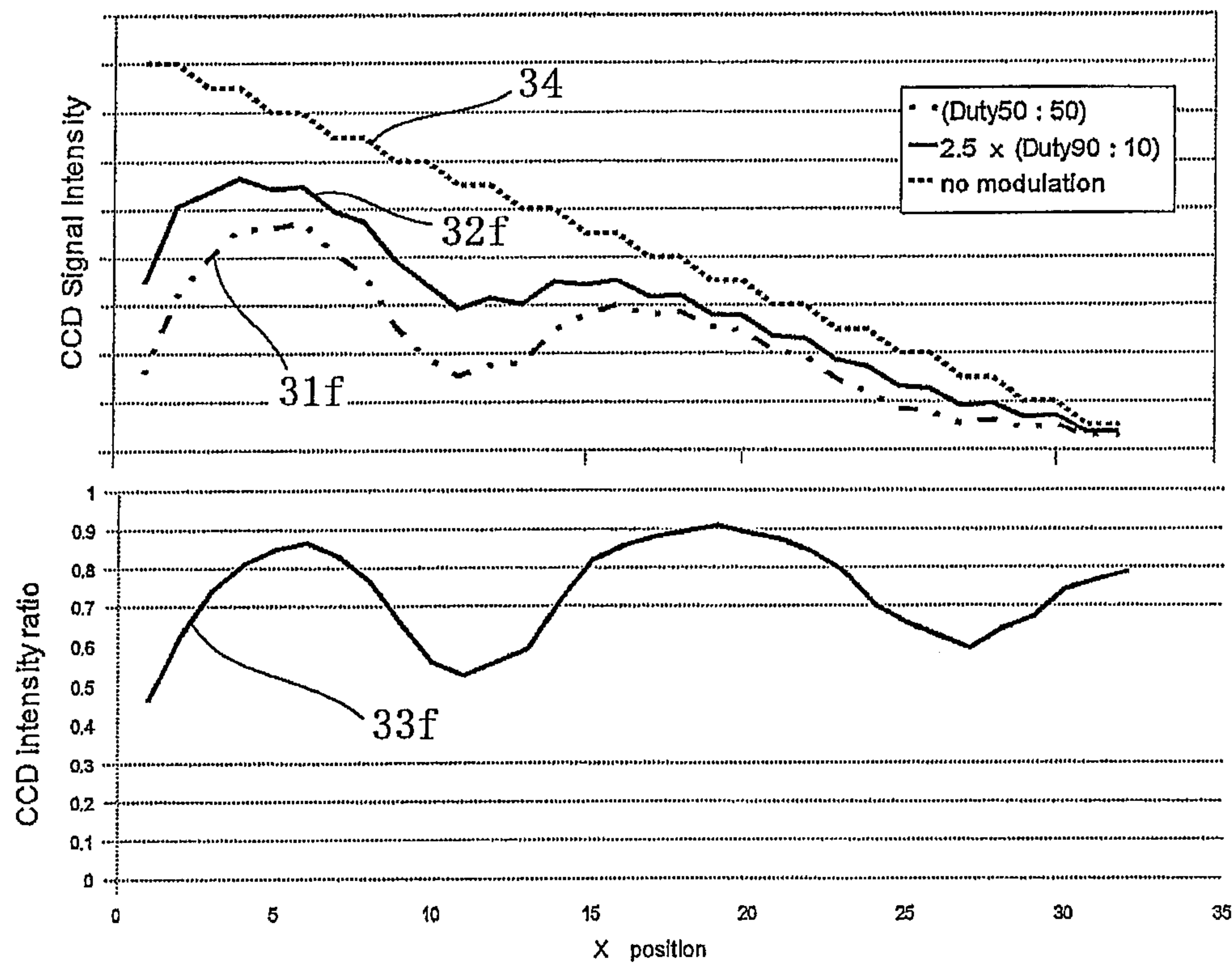


Fig. 25 [25]



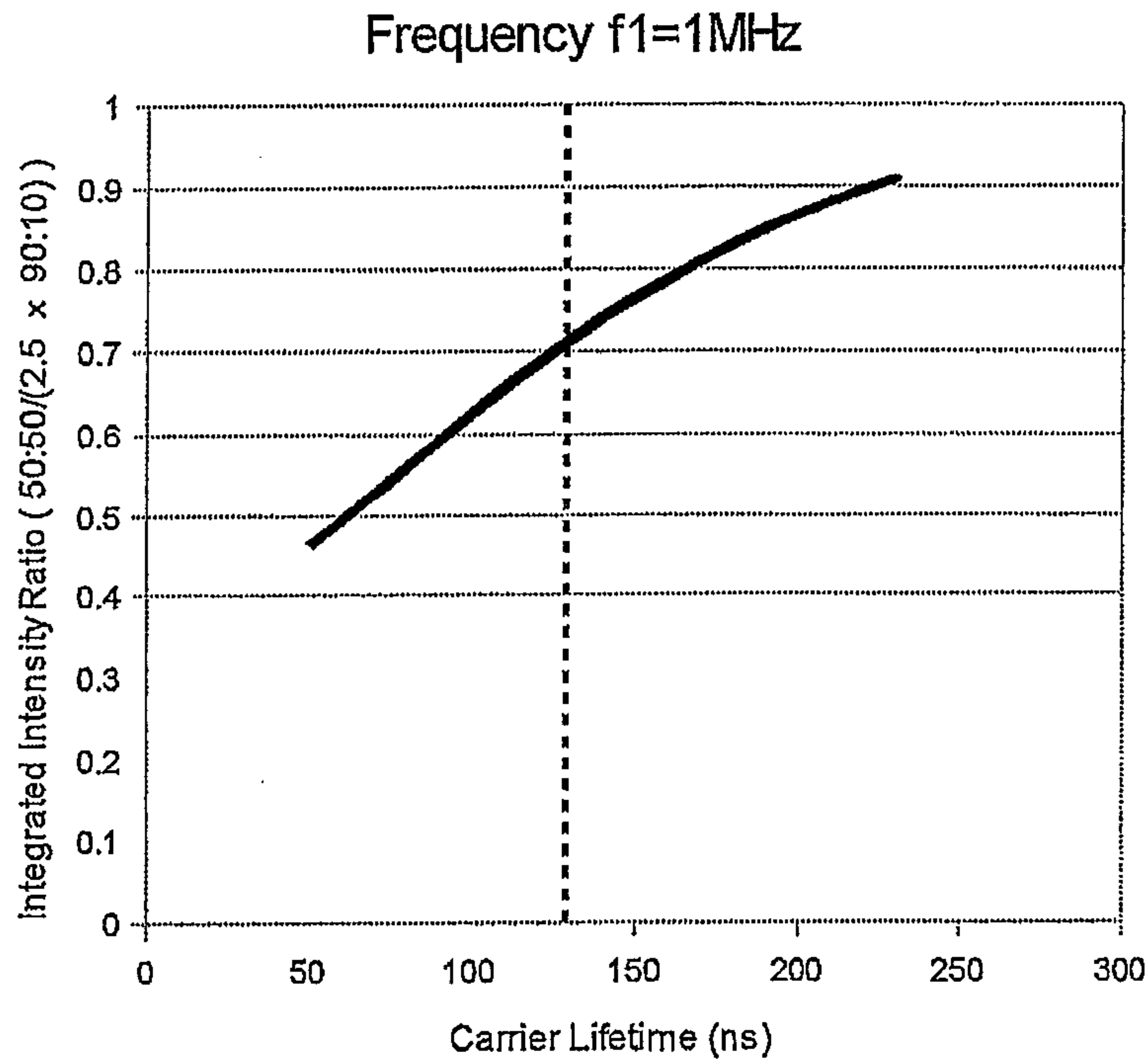
[圖26]

Fig. 26

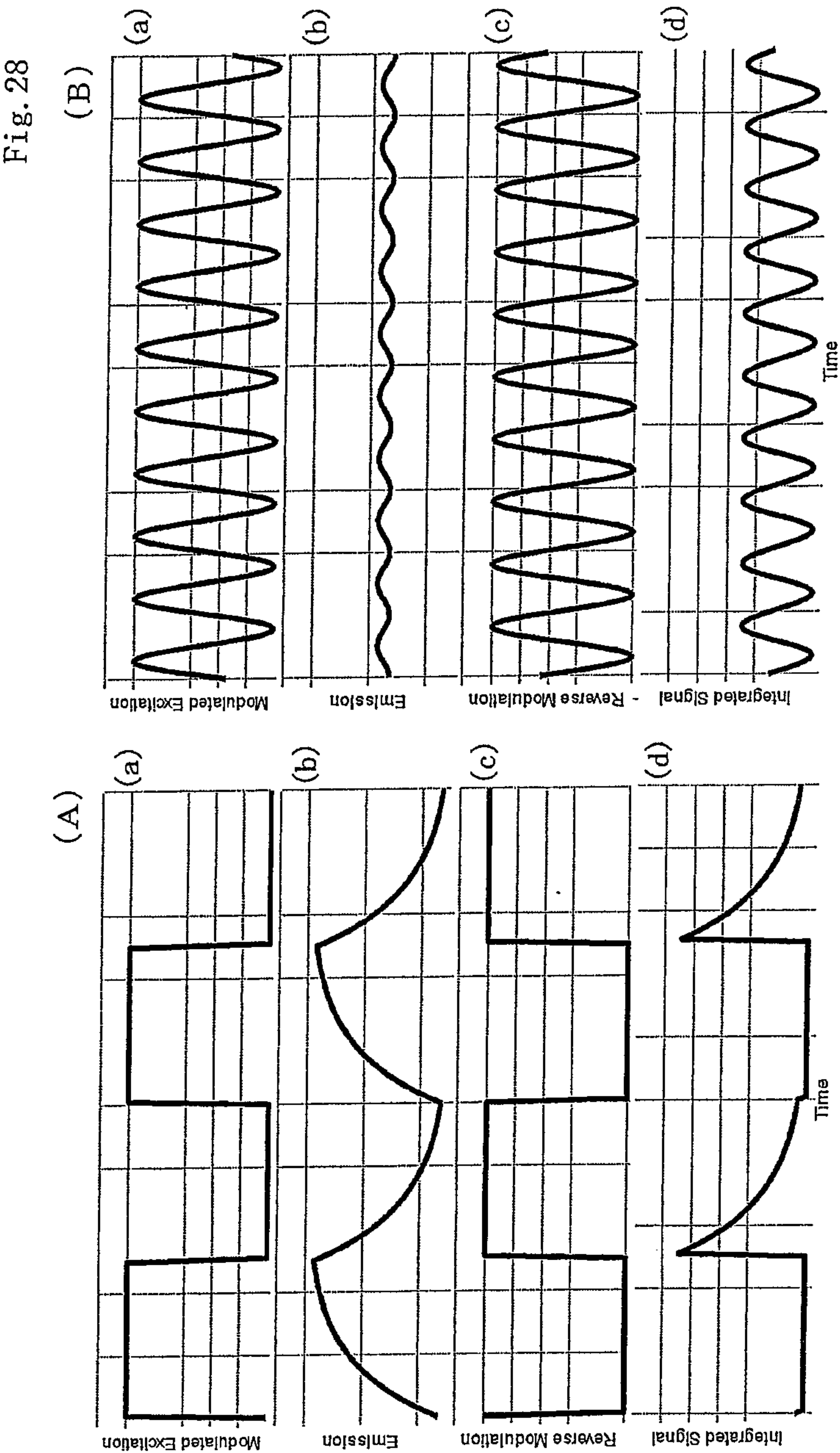


[圖27]

Fig. 27

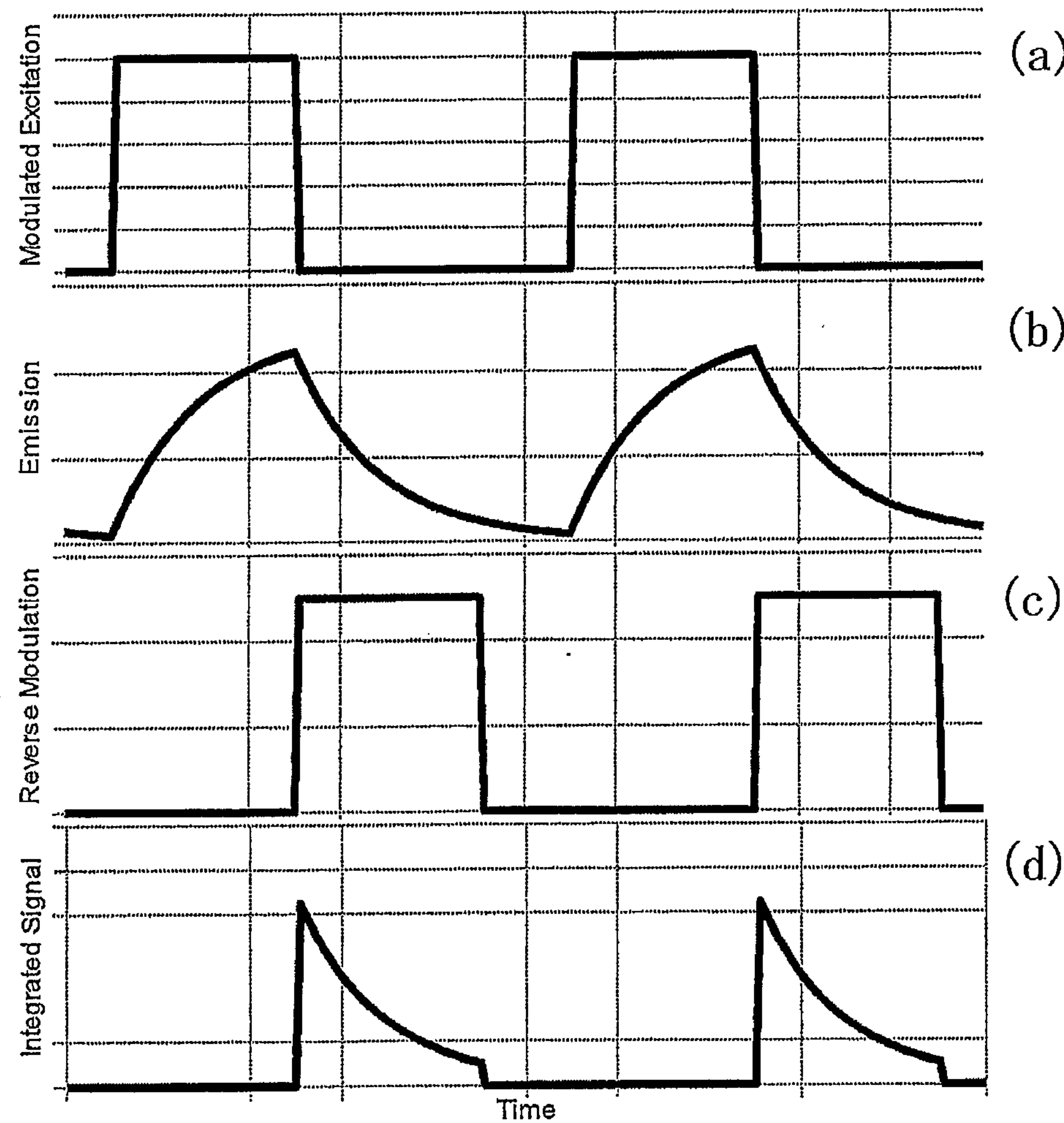


[圖28]



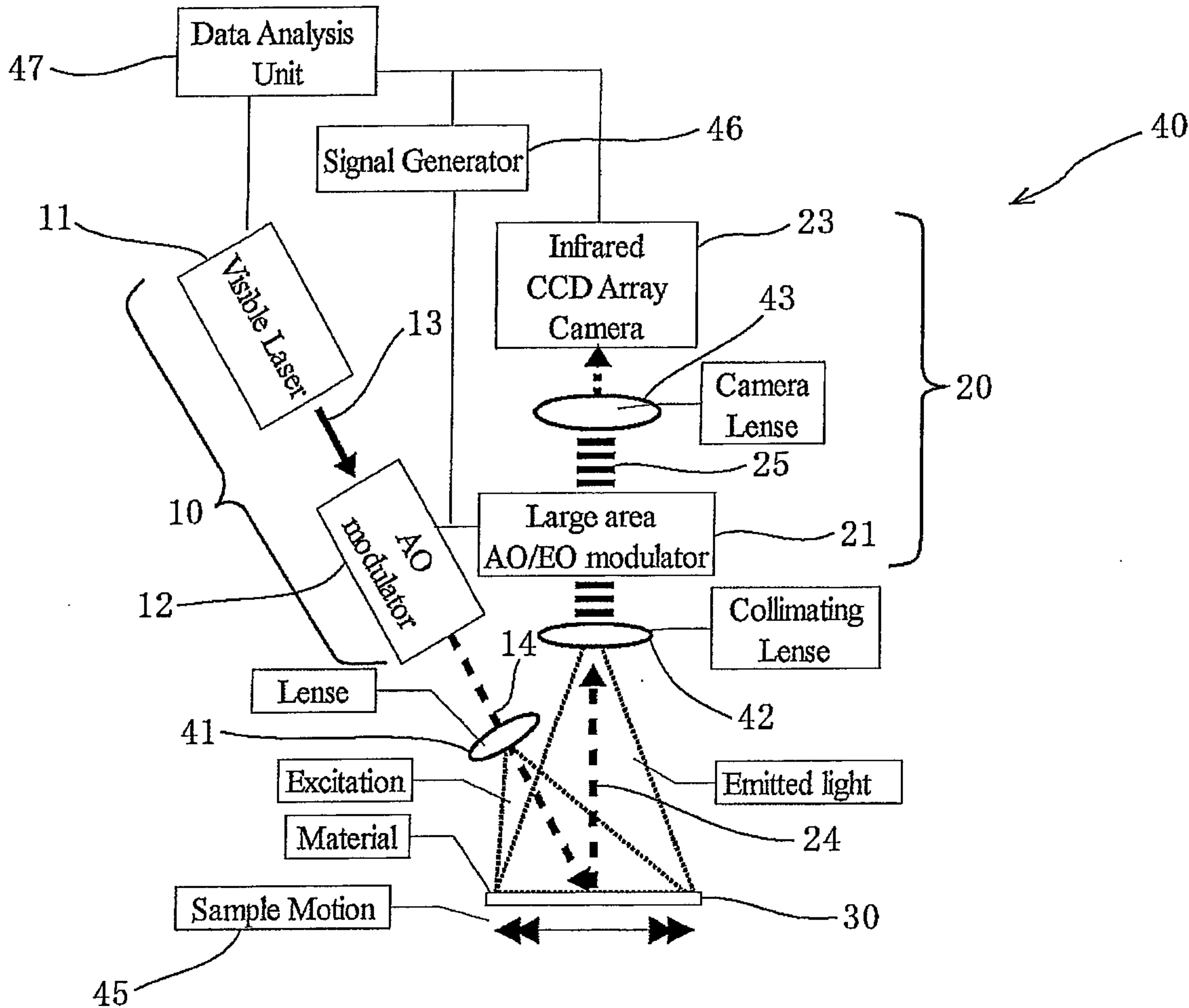
[圖29]

Fig. 29



[図30]

Fig. 30



[図31]

Fig. 31

